TI-PMLK
TI Power Management Lab Kit
Boost Experiment Book
<table>
<thead>
<tr>
<th>Name</th>
</tr>
</thead>
<tbody>
<tr>
<td>University/Company name</td>
</tr>
<tr>
<td>Address</td>
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<tr>
<td>E-mail</td>
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</table>
Many people have collaborated with me in the realization of the TI-PMLK project, in different times, at different levels, in different ways. My sincerest thanks go to the Texas Instruments University Program Team and to the University of Salerno Power Electronics Laboratory Team.

Nicola Femia
Preface

Design is an exciting and fascinating art. Power electronics, for its interdisciplinarily nature, is a challenging field where the knowledge of why makes all the difference in understanding how to achieve design goals. The will of learning and the means for learning are the two basic ingredients needed to develop the virtuous ability to understand the reality of problems, to select the appropriate techniques and methods to solve them, to make meaningful design decisions and to intelligently evaluate the solutions.

The main purpose of the TI-PMLK collection of Experiment Books is to stimulate the spirit of investigation in students and practicing engineers who are engaged in learning and understanding the design of power supplies. The experiments cover a basic anthology of topics and issues encountered in the design of low power dc-dc non-isolated power supplies, such as power supplies topologies and characteristics, modes of operation, efficiency, control, stability, accuracy, transient response, noise, power magnetics, and more. The experiments can be performed by using the power supply boards of the TI-PMLK suite, which includes low dropout linear regulators and buck, boost and buck-boost switching regulators. The Experiment books are not intended to provide an exhaustive overview of design issues or definitive design hints: rather, it is meant to guide the reader into a multifaceted active learning experience.

All the experiments are based on a logical sequence of steps. They start with the Case Study section, which provides the description of the specific property or feature relevant to the power supply board to be used in the experiment, and illustrates the goal and the type of measurement to be done. The Theory Background section provides a short summary of concepts, models and equations, supporting the interpretation and understanding of the incoming experimental observations. The Measurement Setup section provides the instructions for connecting the instruments needed for the experiments to the board under test. Warnings are provided to prevent main mistakes. The Test section provides instructions on how to execute the measurements, and guidelines on how to analyze and understand the results of the measurements. Each test includes an Answer section, where the user is required to answer questions and to provide a discussion about the behavior of the board under test, relevant to the specific performance under investigation, based on the observation of the measurements results and on the application of concepts and properties illustrated through the various sections of the experiment. The Discussion section provides comments to achieve a better understanding of conceptual and practical correlations among system characteristics and operating performance. The final Experimental Plots section illustrates and discusses the results of some sample measurements.

Felix, qui potuit rerum cognoscere causas...
(Happy, he who could capture the origins of things...)
Publio Virgilio Marone, Mantova 70 B.C. – Brindisi 19 B.C.
The experiments cover a variety of steady-state, transient and dynamic tests. The tests are mostly based on time domain measurements, while some tests focus on the investigation of dynamic properties that are described through frequency response functions, such as the power supply rejection ratio. This allows a user to conduct a complete experience on the characterization and understanding of power supply issues. Most of the experiments require basic laboratory equipment, including a power supply, some multi-meters, an oscilloscope and a load. Some tests require more sophisticated instrumentation, such as a dynamic source, a dynamic load, and a vector network analyzer, for best measurement.

The boards have been designed to allow the investigation of the influence of physical parameters and operating conditions of a power supply on its own performances. Various combinations of power and control components can be selected. Most of them yield operating conditions that fit good engineering standards. Other ones may lead to operating conditions typically undesired in industry applications, such as instability. Thus, the reader can achieve a sound understanding of such real phenomena.

Suggested combinations of power and control parts are provided for each experiment. The user is invited in some experiments to detect combinations that yield a certain operating condition or behavior. The user can select the setup of jumpers and connectors to generate a great variety of conditions. The book provides recommendations and warnings for safe board operation and for effective measurements. Before performing any experiment, the reader is strongly recommended to read carefully all the warnings and the introductory section of the book, where the specific description of the board is provided and information on settings and performance are given, including forbidden combinations and special operating conditions. The reader is also strongly invited to read the manufacturers’ datasheets of all the parts mounted in the boards, especially the control chips, to improve the knowledge and the understanding of each device.

A good knowledge of the power supplies implemented on the boards, supported by the heuristic observations and the models and methods discussed in the book, help the user to distinguish what can be done from what cannot be done.

The level of detail and completeness of models discussed in the Theory Background section vary from experiment to experiment. Sometimes the models include certain specific properties, other times they are simplified or approximated. Achieving familiarity with models is a fundamental learning step: a good power supply designer has to be able to grade the importance of modeling certain properties, at device level as well as at system level, in order to assess if they really provide meaningful and influential information to meet the application requirements. Essential formulas and expressions for the basic analysis of the phenomenon under investigation are mostly introduced without step-by-step theoretical derivations, which are beyond the objectives of the book.

The reader is encouraged to test him(her)self in filling this gap, through an in-depth study of models and methods for the analysis and design of power supplies discussed in the cited references.
The parameters of semiconductor and passive power components mounted on the boards are provided in the book to allow the application of analysis formulas and design equations. All parameters of power components are affected by uncertainty, due to tolerances, ageing and influence factors like temperature, current, voltage and frequency. The values collected in the books have been extracted from the manufacturers’ datasheets in certain reference conditions. The power and control components and sub-circuits of integrated circuits controlling the power supplies, which determine modes of operation and performances, are subjected to the influence of temperature, voltage, current and frequency too. As a consequence, the predictions of formulas and equations provided in the book, based on the parameters of power and control devices, can show different levels of agreement with respect to the results of experimental measurements.

The user is strongly encouraged to read the references provided in the book, to analyze the characteristics and the behavior of integrated circuits and power components of the boards, and to verify if different values of the parameters of components can be used to achieve a better compliance between the results of formulas and the results of experimental measurements. The investigation of real device characteristics and of their influence on overall performance of a power supply is a fundamental component of designers’ work.

The ultimate intention of this book is to accompany the reader through an active experience, made of observations, application of physics and mathematics, reality investigation and system level reasoning. That is engineering insight. The Author hopes the reader may fully enjoy this book and the pleasure of being a design engineer, a creative and autonomous thinker, able to acquire and re-elaborate the knowledge to win ever new design challenges.

Know why, know how!

Nicola Femia

Nicola Femia is Professor at the University of Salerno, Italy, where he teaches Power Electronics and Energetic Intelligence, in the Electronic Engineering and Computer Engineering Master Degree Programs. He leads the Power Electronics and Renewable Sources Laboratory. Over the past 25 years, he has promoted and directed worldwide university and industry research activities and education programs on power electronics, photovoltaic systems, and power design. He has been Visiting Professor at the Electrical Engineering Department of the Stanford University, Stanford, CA, where he taught Power Electronics Control and Energy Aware Design.

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The instrumentation recommended for the execution of the experiments of this book is comprised of:

- DC power supply 0-50V/4A with dynamic voltage mode capability
- DC electronic load 20V/10A with dynamic current mode capability
- 4 digital multimeters with 4½ digit resolution
- 250MHz 4-channels Digital Oscilloscope + 2 current probes 20A/50MHz

The instrumentation used in the lab tests corresponding to the Experimental Plot samples shown in the book is comprised of:

- TTi EX354RT Power Supply 0-70V, 4A (used in the experiments where the board under test had to be fed by a constant DC voltage source)
- Keithley 2420 SourceMeter, 63V, 3.15A (used in the experiments where the board under test had to be fed by a dynamic DC voltage source)
- Sorensen Electronic Load SLM-4 mainframe + SLM series electronic load modules 60V/60A
- 4 Hewlett-Packard 34401A multimeters
- LeCroy WaveRunner 44Xi 400MHz 4-channels Digital Oscilloscope, with 2 Tektronix TCP 305 50A current probe + Tektronix TCP A300 amplifier
The TI-PMLK BOOST is an experimental power supply board based on the two wide input range TPS55340 and LM5122 DC-DC boost regulators.
The TI-PMLK TPS55340 section of the board accepts input voltages in between 5V and 12V, while regulates the output voltage at 24V with maximum load current 1.9A.

Figure 1. Circuit schematic of TI-PMLK TPS55340 boost regulator
<table>
<thead>
<tr>
<th>Designator</th>
<th>Description</th>
<th>Manufacturer</th>
<th>Part Number</th>
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<tr>
<td>C₁, C₂, C₃, C₄, C₅</td>
<td>4.7 µF Capacitor 50V X7R 10% 1206</td>
<td>Taiyo Yuden</td>
<td>UMK316AB7475KL-T</td>
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<td>C₆, C₇</td>
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<td>Kemet</td>
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<td>MuRata</td>
<td>GRM21BR71H474KA88L</td>
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<td>D₁</td>
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<td>L₁</td>
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<td>MSS1278-103MLB</td>
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<td>Coilcraft</td>
<td>MSS1246T-332MLB</td>
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<td>Panasonic Electronic Components</td>
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<td>CRCW080510K0FKEA</td>
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<td>R₃₁</td>
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<td>TT Electronics/IRC</td>
<td>OAR3R010FLF</td>
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<td>Texas Instruments</td>
<td>TPS55340RTE</td>
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(Use the part numbers of components to retrieve, through the manufacturers websites listed in the references, details about parameters and data that are used in the formulae provided for calculations in each experiment)
Figure 2. Plain view of TI-PMLK TPS55340 BOOST regulator board
Connectors
J3 - output voltage
J4 - input voltage

Jumpsers
J5 - connects $C_s$ (4.7µF) output capacitor
J6 - connects to external enable signal
J7 - switching frequency setup:
  - shorted left $\rightarrow f_s = 600$kHz
  - shorted right $\rightarrow f_s = 400$kHz
J8 - connects to external synchronization signal
J17 - error amplifier gain setup:
  - shorted left $\rightarrow$ connects parts $R_7$, $C_{10}$, $C_8$
    (lower cross-over frequency with $L=10$µH)
  - shorted right $\rightarrow$ connects parts $R_8$, $C_9$, $C_{11}$
    (higher cross-over frequency with $L=10$µH)
J9 - connects grounds of TPS55340 and LM5122 board sections
J10 - connects inductor $L_1$ (ferrite core, 10µH)
J11 - connects inductor $L_2$ (ferrite core, 3.3µH)
J21-J22 - by-passes the loss emulation resistor $R_1$

High current jumpers
J1-J5 - connects inductor $L_1$ (ferrite core, 10µH)
J5-J10 - connects inductor $L_2$ (ferrite core, 3.3µH)

Voltage and Current Measurements
• hang a current probe to the shunt resistor $R_{31}$ to measure the inductor current
• use TP3 and TP4 to measure the input voltage
• use TP5 and TP6 to measure the output voltage
• use TP2 and TP3 to measure the switching node voltage
• use TP17 and TP6 to measure the feedback voltage
• hang a current probe to one of the external power wires connected to $J_8$
  to measure the input current
• hang a current probe to one of the external power wires connected to $J_3$
  to measure the load current

Test pins
TP3 - positive pole of input voltage
TP6 - ground pole of input voltage
TP4 - positive pole of output voltage
TP5 - ground pole of output voltage
TP1 - can be used together with TP2 to sense the inductor voltage, and together with TP4 to sense the voltage across the current shunt resistor $R_{31}$ and the loss emulation resistor $R_1$ (when J21-J22 are open). The shunt resistor $R_{31}$ allows to hang a current probe for inductor current measurement.
TP2 - switching node
TP3 - feedback voltage
TP6 - connection pin for loop gain measurements, can be used together with TP4 to inject the ac stimulus into the 10Ω resistor $R_6$
TP17 - control voltage
TP18 - soft-start voltage
The TI-PMLK LM5122 section of the board accepts input voltages in between 9V and 20V, while regulates the output voltage at 24V with maximum load current 2A.

**Figure 3.** Circuit schematic of TI-PMLK LM5122 BOOST regulator
<table>
<thead>
<tr>
<th>Designator</th>
<th>Description</th>
<th>Manufacturer</th>
<th>Part Number</th>
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<tr>
<td>C12</td>
<td>470pF ceramic capacitor 100V NP0 5% C0G/NP0 0805</td>
<td>Murata</td>
<td>GRM216SC2A471JA01D</td>
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<td>TDK</td>
<td>C322S5X7R1H106M250AC</td>
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<td>Panasonic Electronic Components</td>
<td>EEE-FPV331AP</td>
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<td>Kemet</td>
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<td>Murata</td>
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<td>C35</td>
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<td>Murata</td>
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<td>Rohm Semiconductor</td>
<td>RB160M-60TR</td>
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<td>L1, L2</td>
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<td>Coilcraft</td>
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<td>CRCW080510R0FKEA</td>
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<td>Vishay Dale</td>
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<td>U2</td>
<td>Wide Input Synchronous Boost Controller with Multiple Phase Capability, PWP0020A</td>
<td>Texas Instruments</td>
<td>LM5122MH/NOPB</td>
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(Use the part numbers of components to retrieve, through the manufacturers websites listed in the references, details about parameters and data that are used in the formulae provided for calculations in each experiment)
Figure 4. Plain view of TI-PMLK LM5122 BOOST regulator board
TI-PMLK LM5122 Connectors, Jumpers and Test Pins

Descriptors and functions for Connectors, Jumpers and Test Pins

Connectors

J11 - input voltage
J12 - output voltage

Jumpers

J13 - connects to external synchronization signal
J14 - compensation slope setup:
  - open → lower slope
  - shorted → higher slope
J15 - switching frequency setup:
  - shorted → fs = 500kHz
  - open → fs = 250kHz
J16 - diode emulation setup:
  - open → diode emulation
  - shorted left → forced PWM
  - shorted right → diode emulation with skip cycle
J18 - error amplifier gain setup:
  - connects parts R13, C13, C13 (high cross-over frequency with L=10µH, and high slope compensation ramp)
J19 - error amplifier gain setup:
  - connects parts R23, C23, C23 (higher cross-over frequency with L=10µH, and low slope compensation ramp)
J20 - error amplifier gain setup:
  - connects parts R37, C37, C37 (lower cross-over frequency with L=10µH, and low slope compensation ramp)
J9 - connects grounds of LM5122 and TPS55340 sections

High current jumpers

J23-J24 - connects inductor L3 (powdered core, 10µH)
J24-J25 - connects inductor L4 (powdered core, 3.3µH)

Test pins

TP11 - positive pole of input voltage
TP12 - ground pole of input voltage
TP13 - positive pole of output voltage
TP14 - ground pole of output voltage
TP9 - can used together with TP10 to sense the inductor voltage, and together with TP11 to sense the voltage across the current shunt R11. The shunt resistor R11 allows to hang a current probe for inductor current measurement.
TP15 - switching node
TP16 - connection pin for loop gain measurements, can be used together with TP12 to inject the ac stimulus into the 10Ω resistor R20

Test pins

TP16 - control voltage

Voltage and Current Measurements

- hang a current probe to the shunt resistor R11 to measure the inductor current
- use TP11 and TP13 to measure the input voltage
- use TP12 and TP14 to measure the output voltage
- use TP10 and TP13 to measure the switching node voltage
- use TP16 and TP14 to measure the control voltage
- hang a current probe to one of the external power wires connected to J11 to measure the input current
- hang a current probe to one of the external power wires connected to J10 to measure the load current
TPS55340 BOARD:
• The compensation set with J17 shorted letf side is tailored to achieve about 45° phase margin at 1.5kHz cross-over frequency with inductance L=10µH (J1-J5 shorted), at minimum input voltage and maximum load current
• The compensation set with J17 shorted right side is tailored to achieve about 45° phase margin at 6.5kHz cross-over frequency with inductance L=10µH (J1-J5 shorted), at minimum input voltage and maximum load current

LM5122 BOARD:
• The compensation set with J18 shorted, J19 open and J20 open is tailored to achieve about 52° phase margin at 6kHz cross-over frequency with inductance L=10µH (J1-J5 shorted), and slope compensation resistance R_sl=10kΩ (J14 shorted), at minimum input voltage and maximum load current
• The compensation set with J19 shorted, J18 open and J20 open is tailored to achieve about 52° phase margin at 6kHz cross-over frequency with inductance L=10µH (J1-J5 shorted), and slope compensation resistance R_sl=100kΩ (J14 open), at minimum input voltage and maximum load current
• The compensation set with J20 shorted, J18 open and J19 open is tailored to achieve about 52° phase margin at 600Hz cross-over frequency with inductance L=10µH (J1-J5 shorted), and slope compensation resistance R_sl=100kΩ (J14 open), at minimum input voltage and maximum load current
• The resistor R11 senses the inductor current and generates a voltage signal which is used by the LM5122 current mode controller. The resistor R11 has a parasitic inductance of about 30nH, which determines the action of the current limit if the 3.3µH powdered core inductor L4 is connected and the load current exceeds about 15mA. The effects of parasitic inductances on current sensing is current mode control discusses in Experiment 3.

WARNINGS AND RECOMMENDATIONS

NOTES

TPS55340 BOOST REGULATOR
1) DO NOT operate the regulator with J17 OPEN ON BOTH SIDES
2) DO NOT operate the regulator with both J1 AND J5 AND J10 ALL OPEN

LM5122 BOOST REGULATOR
1) DO NOT operate the regulator with J18 AND J19 AND J20 ALL OPEN
2) DO NOT operate the regulator with J18 AND J19 AND J20 ALL SHORTED
3) DO NOT operate the regulator with J18 AND J19 SHORTED
4) DO NOT operate the regulator with J19 AND J20 SHORTED
5) DO NOT operate the regulator with J18 AND J20 SHORTED
6) DO NOT operate the regulator with both J23 AND J24 AND J25 ALL OPEN
7) DO NOT operate the regulator with J24-J25 SHORTED, which connects inductor L4 (powdered core, 3.3µH), until you perform Experiment 3.

GENERAL
1) DO NOT exceed input and output voltage and current ratings
2) If the board is terminated in the output onto an electronic load in constant current mode, the sequence to follow is:
   a) at the turn on: turn on the input power supply then turn on the load
   b) at the turn off: turn off the load then turn off the input power supply
3) Whatever change in the setup of jumpers has to be done, the board has to be shut down first.
Experiment 1

The goal of this experiment is to analyze the influence of input voltage, load current and switching frequency on the continuous mode operation and discontinuous mode operation of the boost converter. The LM5122 BOOST regulator is used for this experiment.
The goal of this experiment is to analyze the impact of input voltage, load current and switching frequency on the continuous/discontinuous operation of the boost converter, and to analyze how the duty-cycle changes with the operating conditions and with the operation mode.

The Ti-PMLK LM5122 boost regulator operates with $V_{in}=\[9,20\]V$, while regulating the output voltage at the nominal value $V_{out}=24V$, $I_{out}=\[0,2\]A$. Fig.1 shows the simplified circuit schematic of the regulator. The LM5122 boost regulator can operate in two different modes, depending on the setup of jumper $J_{16}$. When $J_{16}$ is open, the $Q_1$ gate drive is disabled so that the $Q_1$ channel is permanently open and the LM5122 operates in Diode Emulation Mode (DEM), as the conduction from the inductor to the output is realized by means of the body diode of the MOSFET $Q_1$. In these conditions the boost converter can operate in Discontinuous Conduction Mode (DCM) at low load. When $J_{16}$ is shorted between the LM5122 MODE PIN and the $V_{CC}$ voltage, the $Q_1$ gate drive is enabled so that $Q_1$ works as a synchronous switch and the LM5122 operates in Synchronous Operation Mode (SOM). In these conditions the boost converter operates always in Continuous Conduction Mode (CCM), for all values of current delivered to the load. For given input voltage $V_{in}$ and load current $I_{out}$, the relation between the input voltage $V_{in}$, the output voltage $V_{out}$ and the duty-cycle $D$ is different between DEM and SOM setup.

Test#1. We investigate the operation of the boost converter in CCM and in DCM, and we measure the duty-cycle while varying the input voltage and the load current. The DCM is detected by analyzing the inductor current waveform flowing through the current sensing resistor $R_s$ ($R_{11}$ in the board) and the duty-cycle is measured by analyzing the switching node voltage at TEST PIN TP10. The test is realized for given input voltage and load current conditions and with different setup of jumper $J_{16}$, which sets the DEM or SOM. The goal is to analyze how the DCM influences the duty-cycle of the boost converter for given input voltage and load current.

Test#2. We analyze the impact of the switching frequency on the operation of the boost converter with DEM setup, while varying the input voltage. The test is realized for three values of the load current, and for two values of the switching frequency, which is fixed by the setup of jumper $J_{16}$. The goal is to see the effect of switching frequency on the input voltage operation range during DCM, and to see the correlation between the theoretical formula that predicts the DCM operation neglecting the power losses.
Experiment 1

Theory Background

The boost converter characteristics with DEM and SOM setup can be analyzed by means of the formulae provided in this section (see [1][2] for more details on boost topology operation and CCM/DCM modeling; see [4] for more details on LM5122 operation and features).

**Load current above the DCM threshold**

The load current $I_{out}$ influences the CCM/DCM operation of the boost converter. The threshold value which can determine a possible change in the operation mode is given by formula (1):

\[ I_{dcm} = \frac{V_{out} (M-1)}{2M^2 f_s L} \]

where $M = \frac{V_{out}}{V_{in}}$.

The boost converter operates in CCM for $I_{out} > I_{dcm}$. Figure 1 shows the inductor current and voltage waveforms. For an ideal loss-less boost converter in CCM the duty-cycle $D_{cm}$ is related to the voltage conversion ratio $M$ through the formula (2):

\[ D_{cm} = 1 - \frac{1}{M} \]

The inductor current slopes, average, peak and valley values are then given by:

\[ (3) \quad s_1 = \frac{V_{in}}{L}, \quad s_2 = \frac{V_{out} - V_{in}}{L}, \quad i_L = \frac{I_{out}}{1 - D_{cm}} \]

\[ (4) \quad I_{pk,cm} = i_L + \frac{D_{cm}}{2f_s}, \quad i_L = i_L(1 - D_{cm}) \]

Due to the power losses, the real voltage conversion ratio $M$ and the duty-cycle $D_{cm}$ in CCM depend on the load current:

\[ (4) \quad M = \frac{1}{(1 - D_{cm})} - \frac{P_L}{V_{in} I_{out}}, \quad D_{cm} = 1 - \frac{V_{in} I_{out}}{P_L + P_d} \]

where $P_L$ are the total losses of the power converter, which do depend on the duty-cycle $D_{cm}$ as well. Increasing the power losses reduces the maximum allowed step-up conversion ratio $M_{max}$ and increases the duty-cycle needed to get a given ratio $M$.

**Load current below the DCM threshold**

If $I_{out} < I_{dcm}$ in DEM the LM5122 boost regulator operates in DCM. The duty-cycle is given by (5):

\[ D_{dm} = \sqrt{\frac{M(M-1)\frac{1}{K}}{V_{out}}} \]

where $K = \frac{2f_s I_{out} L}{V_{out}}$.

Formula (5) does not include power losses effect and shows that the duty-cycle $D_{dm}$ in DCM inherently depends on the load current. Figure 4 compares inductor current and voltage ideal waveforms (the effect of parasitic capacitance is neglected) in DEM and SOM for $I_{out} < I_{dcm}$. For DEM it is $I_{pk,cm} = s_1 D_{dm}/f_s$ and $i_L(1 - D_{dm}) = 0$. The formulae (2) and (3) are still valid for SOM.

In DEM-DCM, for any value of the duty-cycle $D_{dm}$, the voltage conversion ratio $M$ is also dependent on the load, and is given by (6):

\[ M = \frac{1}{2} + \frac{1}{4} \frac{1 + D_{dm}^2}{K} \]

Figure 5(a) shows the plot of the formula (6). DCM is operated for values of the line voltage $V_{in}$ falling within a certain range $[V_{min}, V_{max}]$, which depends on the load current $I_{out}$ and switching frequency $f_s$, as shown in Figure 5(b). The magenta and green curves are obtained with $I_{out} = I_{dcm}$ at $f_s = 250$kHz and $f_s = 500$kHz.
The instruments needed for this experiment are: a DC POWER SUPPLY, four MULTIMETERS, an OSCILLOSCOPE and a DC ELECTRONIC LOAD. Figure 6 shows the instruments connections. Follow the instructions provided in next page to set-up the connections.

Figure 6. Experiment set-up.
Experiment set-up: instructions

With all the instruments turned off, make the following connections:

1) connect the POSITIVE (RED) OUTPUT of the DC POWER SUPPLY to the POSITIVE (RED) CURRENT INPUT of the INPUT CURRENT MULTIMETER (ICM)
2) connect the NEGATIVE (BLACK) CURRENT INPUT of the INPUT CURRENT MULTIMETER (ICM) to the INPUT (VIN) of the J₁₁ screw terminal of the LM5122 boost regulator
3) connect the NEGATIVE (BLACK) OUTPUT of the DC POWER SUPPLY to the GROUND (GND) of the J₁₁ screw terminal of the LM5122 boost regulator
4) connect the OUTPUT (VOUT) of the J₁₂ screw terminal of the LM5122 boost regulator to the POSITIVE (RED) CURRENT INPUT of the OUTPUT CURRENT MULTIMETER (OCM)
5) connect the NEGATIVE (BLACK) CURRENT INPUT of the OUTPUT CURRENT MULTIMETER (OCM) to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD
6) connect the NEGATIVE (BLACK) INPUT of the ELECTRONIC LOAD to the GROUND (GND) of the J₁₂ screw terminal of the LM5122 boost regulator
7) connect the POSITIVE (RED) VOLTAGE INPUT of the INPUT VOLTAGE MULTIMETER (IVM) to the TEST PIN TP₁₁ which is the VIN of the LM5122 boost regulator
8) connect the NEGATIVE (BLACK) VOLTAGE INPUT of the INPUT VOLTAGE MULTIMETER (IVM) to the TEST PIN TP₁₃ which is GND of the LM5122 boost regulator
9) connect the POSITIVE (RED) VOLTAGE INPUT of the OUTPUT VOLTAGE MULTIMETER (OVM) to the TEST PIN TP₁₂ which is VOUT of the LM5122 boost regulator
10) connect the NEGATIVE (BLACK) VOLTAGE INPUT of the OUTPUT VOLTAGE MULTIMETER (OVM) to the TEST PIN TP₁₄ which is GND of the LM5122 boost regulator
11) connect a current probe to channel 1 of the oscilloscope and hang it on the sensing resistor \( R_{11} \) of the LM5122 boost regulator, ensuring that the arrow printed on the probe clamps corresponds to the current that enters the inductor (the arrow must point upside when looking the LM5122 boost board frontally, as shown in Figure 6)
12) connect a voltage probe to channel 2 of the oscilloscope and hang it on the TEST PIN TP₁₀ which is the switching node voltage of the LM5122 boost regulator
**Test#1: preparation and procedure**

**Initial jumpers set-up (see Figure 7):**
- \( J_{13} \) open → no external synchronization signal connected
- \( J_{14} \) shorted → high slope current mode compensation
- \( J_{15} \) shorted → switching frequency \( f_s = 500 \text{kHz} \)
- \( J_{16} \) open → DEM setup (change to \( J_{16} \) shorted on the left → SOM setup, according to Measure and Calculate section instructions)
- \( J_{18} \) shorted, \( J_{23} \) open, \( J_{24} \) open → error amplifier gain setup with parts \( R_{23}, C_{28}, C_{33} \) connected (high cross-over frequency with \( L_s = 10 \mu \text{H} \), and high slope compensation ramp)
- \( J_{23}-J_{24} \) shorted → \( L_s (10 \mu \text{H}) \) inductor connected

**Figure 7. LM5122 board: jumpers set-up for Test#1**

**Test Procedure:**
1) Turn on the MULTIMETERS, set the ICM and the OCM in DC CURRENT MODE, set the IVM and the OVM in DC VOLTAGE MODE
2) Turn on the OSCILLOSCOPE, set the CH-1 in DC \( 50 \Omega \) coupling mode, set the CH-2 in DC \( 1 \text{M} \Omega \) coupling mode, select CH-2 as trigger source, and execute the “de-gauss” of the current probe to remove possible dc bias in the current probe
3) Turn on the POWER SUPPLY (ensure that the OUT ON button is OFF), set the voltage at the initial value of 10V, and set the CURRENT LIMIT > 5A
4) Turn on the ELECTRONIC LOAD (ensure that the LOAD ON button is OFF), set the CONSTANT CURRENT MODE, and set the current at 0.2A
5) Turn on the POWER SUPPLY “OUT ON” button and adjust the DC POWER SUPPLY knob until you read 10V in the IVM display. In these conditions you should read about 24V in the OVM display, 0A in the OCM display and a very small positive value in the ICM display (if you do read values different than as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
6) Turn on the ELECTRONIC LOAD ON button and adjust the DC POWER SUPPLY knob until you read 10V in the IVM display. In these conditions you should read about 24V in the OVM display, 0.2A in the OCM display, about 0.5A in the ICM display, and see a triangular waveform with about 0.5A average value on CH-1 of the OSCILLOSCOPE and a swinging wave on CH-2 of the OSCILLOSCOPE (if the values you read and the waveforms you see do not look as described above, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY and verify the experiment setup)
7) Read the input voltage value on the IVM display, the output voltage value on the OVM display, watch at the inductor current waveform on CH-1 of the OSCILLOSCOPE to assess whether the regulator is operating in CCM or DCM, measure the frequency and duty-cycle of the switching node voltage on CH-2 of the OSCILLOSCOPE, and use these values according to Measure and Calculate section instructions. Repeat this step for all the load current and input voltage values listed in Table 1 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button and the ELECTRONIC LOAD “LOAD ON” button while changing the input voltage and the load current)
8) Turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, open the jumper \( J_{16} \) to setup LM5122 DEM operation and repeat steps from 3) to 7)
9) At the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments.
Test#1: measure and calculate

For each combination of the LM5122 boost regulator setup (DEM/SOM) and operating conditions \((V_{in}, I_{out})\) indicated in Table 1:

1) predict the CCM/DCM operation based on the relation between \(I_{out}\) and \(I_{dc}\) illustrated in the Theory Background section and fill the cell \((1)\) with “CCM” or “DCM” label accordingly, verify whether the LM5122 boost regulator is operating in CCM or in DCM based on observation of the experimental inductor current waveform and fill the cell \((2)\) with “CCM” or “DCM” label accordingly

2) based on the CCM/DCM operation predicted at point 1), calculate the duty-cycle \(D_{th}\) by means of the formulae (2), (5) and (6) given in the Theory Background section and report the result in cell \((3)\)

3) measure the experimental duty-cycle \(D_{ex}\) of the LM5122 boost regulator and report the result in cell \((4)\)

Table 1. Duty-cycle of the boost converter at \(f_s = 500kHz\) with \(L = 10\mu H\), with DEM and SOM setup.

<table>
<thead>
<tr>
<th>(V_{in})</th>
<th>(I_{out})</th>
<th>(D_{th}) [%]</th>
<th>(D_{ex}) [%]</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>SOM operation</td>
<td></td>
<td>DEM operation</td>
</tr>
<tr>
<td></td>
<td>(I_{out}=0.2A)</td>
<td>(I_{out}=0.4A)</td>
<td>(I_{out}=1.2A)</td>
</tr>
<tr>
<td>(10V)</td>
<td>(1)</td>
<td>(2)</td>
<td>(3)</td>
</tr>
<tr>
<td>(15V)</td>
<td>(1)</td>
<td>(2)</td>
<td>(3)</td>
</tr>
<tr>
<td>(20V)</td>
<td>(1)</td>
<td>(2)</td>
<td>(3)</td>
</tr>
</tbody>
</table>

Inductor:
- \(J_{23-J24}\) shorted → inductor \(L_3\) (powdered core, 10\(\mu H\), 2.6A, 0.057\(\Omega\)) connected
- \(J_{24-J25}\) shorted → inductor \(L_4\) (powdered core, 3.3\(\mu H\), 10A, 0.0195\(\Omega\)) connected

Switching frequency:
- \(J_{15}\) open → \(f_s = 250kHz\)
- \(J_{15}\) shorted → \(f_s = 500kHz\)

Operation mode:
- \(J_{16}\) open → Diode Emulation Mode (DEM)
- \(J_{16}\) shorted left → Synchronous Operation Mode (SOM)

Answer:

1. Is the duty-cycle in DCM operation lower than in CCM operation?
   - yes
   - no
   - it depends on load current
   - it depends on line voltage

2. Does the experimental duty-cycle increase with the load current?
   - yes
   - no
   - it does in DCM operation
   - it does in CCM operation

3. Does the load current influence the duty-cycle more in DCM than in CCM?
   - yes
   - no
   - it depends on line voltage
Initial jumpers set-up (see Figure 8):

- J13 open → no external synchronization signal connected
- J14 shorted → high slope current mode compensation
- J15 open → switching frequency \( f_s = 250\text{kHz} \)
- J16 open → DEM setup
- J18 shorted, J19 open, J20 open → error amplifier gain setup with parts \( R_{23}, C_{28}, C_{33} \) connected (high cross-over frequency with \( L = L_3 = 10\mu\text{H} \), and high slope compensation ramp)
- J23 - J24 shorted → \( L_3 = 10\mu\text{H} \) inductor connected

Test Procedure:

1) turn on the MULTIMETERS, set the ICM and the OCM in DC CURRENT MODE, set the IVM and the OVM in DC VOLTAGE MODE
2) turn on the OSCILLOSCOPE, set the CH-1 in DC 50Ω coupling mode, set the CH-2 in DC 1MΩ coupling mode, select CH-2 as trigger source, and execute the “de-gauss” of the current probe to remove possible dc bias in the current probe
3) turn on the POWER SUPPLY (ensure that the OUT ON button is OFF), set the voltage at the initial value of 10V, and set the CURRENT LIMIT > 5A
4) turn on the ELECTRONIC LOAD (ensure that the LOAD ON button is OFF), set the CONSTANT CURRENT MODE, and set the current at 0.3A
5) turn ON the POWER SUPPLY “OUT ON” button and adjust the DC POWER SUPPLY knob until you read 10V in the IVM display. In these conditions you should read about 24V in the OVM display, 0A in the OCM display and a very small positive value in the ICM display (if you do read values different than as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
6) turn ON the ELECTRONIC LOAD ON button and adjust the DC POWER SUPPLY knob until you read 10V in the IVM display. In these conditions you should read about 24V in the OVM display, 0.3A in the OCM display, about 0.75A in the ICM display, and see a triangular waveshape with about 0.75A average value on CH-1 of the OSCILLOSCOPE and a swinging wave on CH-2 of the OSCILLOSCOPE (if the values you read and the waveforms you see do not look as described above, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY and verify the experiment setup)
7) while slowly rising the input voltage from 10V to 20V (read the input voltage on the IVM display, not on DC POWER SUPPLY display), watch the inductor current waveform on CH-1 of the OSCILLOSCOPE to assess whether the regulator is operating in CCM or DCM, detect the minimum and maximum input voltage values for which the regulator operates in DCM, and report these values in Table 2. Repeat this step for all the load current values listed in Table 2 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button and the ELECTRONIC LOAD “LOAD ON” button while changing the input voltage and the load current)
8) turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, short the jumper J15 to setup the switching frequency at \( f_s = 500\text{kHz} \) and repeat steps from 3) to 7)
9) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments.
Test#2: measure and calculate

For each combination of switching frequency $f_s$ and load current $I_{out}$ indicated in Table 2:
1) report the minimum input voltage $V_{in_{min}}$ and the maximum input voltage $V_{in_{max}}$ for which the LM5122 boost regulator is operating in DCM, based on the observation of the experimental inductor current waveform (write “CCM” into the cells (1) and (2) in case the regulator operates in CCM for whatever voltage from 10V to 20V)
2) based on the formula (1) given in the Theory Background section, calculate the $I_{dcm}$ threshold current at the voltages $V_{in_{min}}$ and $V_{in_{max}}$ detected at point 1) and report the result in cells (3) and (4)

Table 2. Impact of load current and switching frequency on the input voltage DCM operation range of LM5122 boost regulator witt DEM setup and $L = 10\mu H$

<table>
<thead>
<tr>
<th>$I_{out}$</th>
<th>$V_{in_{min}}$ [V]</th>
<th>$V_{in_{max}}$ [V]</th>
<th>$I_{dcm}$ @$V_{in_{min}}$ [A]</th>
<th>$I_{dcm}$ @$V_{in_{max}}$ [A]</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.3A</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0.6A</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0.9A</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Inductor:
- $J_{23}$-$J_{24}$ shorted → inductor L3 (powdered core, 10\mu H, 2.6A, 0.057\Omega) connected
- $J_{24}$-$J_{25}$ shorted → inductor L4 (powdered core, 3.3\mu H, 10A, 0.0195\Omega) connected

Switching frequency:
- $J_{15}$ open → $f_s = 250kHz$
- $J_{15}$ shorted → $f_s = 500kHz$

Operation mode:
- $J_{10}$ open → Diode Emulation Mode (DEM)
- $J_{10}$ shorted left → Synchronous Operation Mode (SOM)

Answer:
1) Does a higher load current expand the input voltage range where the boost regulator operates in DCM?
   - [ ] yes
   - [ ] no, it reduces the range
   - [ ] it depends on switching frequency
   - [ ] other: __________________________

2) Identify the factors determining the reduction of input voltage range wherein the boost converter operates in DCM: __________________________

3) Are the values $I_{dcm}$ @$V_{in_{min}}$ and $I_{dcm}$ @$V_{in_{max}}$ equal to the value of the load current in the test conditions?
   - [ ] yes
   - [ ] no
   - [ ] it depends on switching frequency
   - [ ] it depends on load current
   - [ ] other: __________________________

Answer: __________________________
In Test#1 we are interested in detecting the CCM/DCM operation mode and measuring the duty-cycle of a boost regulator while varying the input voltage and the load current.

In the Theory Background section, the analysis shows that the LM5122 boost regulator enters DCM when \( I_{\text{out}} < I_{\text{dcm}} \) with DEM setup. The threshold current \( I_{\text{dcm}} \) given by formula (1) depends on the input voltage \( V_{\text{in}} \), the switching frequency \( f_s \), and the inductance \( L \). The formula (1) provides an approximated value of the \( I_{\text{dcm}} \) threshold value, as it neglects the effects of power losses, of the temperature and variations (tolerances) of physical and operating parameters (e.g. inductance \( L \), switching frequency \( f_s \)). The DCM operation can be detected experimentally by observing the waveforms of the inductor current \( i_L \), of the inductor voltage \( v_L \) or of the switching node voltage \( v_{\text{sw}} \). The waveforms of inductor current and voltage in DCM are shown in the Figure 4 of the Theory Background section. In theory, when a boost converter operates in DCM, the inductor current drops to zero before the end of the switching period, and stays at zero until the next switching cycle starts. During this dead interval (see Figure 8 on next page) the inductor voltage is zero, then the switching node voltage should drop below the output voltage and keep a constant value depending on the impedances of the MOSFET and of the diode in the OFF state. In a real boost converter, during the dead interval the parasitic capacitances of the MOSFET and of the diode form a resonant loop with the inductor, which causes oscillations in the inductor current and at the switching node voltage, as shown in Figure 8. The DCM operation can be assessed by detecting whether there is a zero crossing in the inductor current waveform, while the duty-cycle can be determined by the measuring the duration \( t_{\text{q2}} \) of the time interval wherein the switching node voltage is clamped to zero because of the MOSFET \( Q_2 \) conduction.

In Test#2 we are interested in analyzing the impact of the switching frequency on the operation of a boost regulator while varying the input voltage.

Given a load current \( I_{\text{out}} \), the LM5122 boost regulator operating with DEM setup enters DCM or CCM depending on whether the load current \( I_{\text{out}} \) is lower or greater than the value of the threshold current \( I_{\text{dcm}} \). The formula (1) provided in the Theory Background section shows that an increase of the switching frequency \( f_s \) causes a decrease of the threshold current \( I_{\text{dcm}} \), and then the LM5122 boost regulator operating with DEM setup operates in CCM over a wider range of values of the load current. The impact of the input voltage on the threshold current \( I_{\text{dcm}} \) is non-monotonic. In contrast, the formula (1) can be derived with respect to the conversion ratio \( M=V_{\text{out}}/V_{\text{in}} \) and it results that if \( V_{\text{in}} > 0.67V_{\text{out}} \) then the threshold current \( I_{\text{dcm}} \) decreases while \( V_{\text{in}} \) increases, whereas if \( V_{\text{in}} < 0.67V_{\text{out}} \) then the threshold current \( I_{\text{dcm}} \) increases while \( V_{\text{in}} \) increases. You can observe from experimental tests that when the load current falls below a certain threshold, the operation of the LM5122 boost regulator with DEM setup becomes irregular, and you may have some difficulty in setting the oscilloscope trigger. This behaviour is determined by a typical property of control ICs, which cannot operate with too small or too large duty-cycle. In particular, the formula (5) shows that the duty-cycle in DCM decreases as the load current decreases. When the load current \( I_{\text{out}} \) is much lower than the threshold current \( I_{\text{dcm}} \), a very small duty cycle is required to achieve the regulation of the output voltage. In these conditions it can happen that the required ON time \( t_{\text{q2}} \) of the MOSFET \( Q_2 \) is lower than the minimum ON time \( t_{\text{ONmin}} \) that the controller can implement. For the LM5122 controller \( t_{\text{ONmin}} \) varies between 150ns and 300ns while the slope compensation resistance \( R_{\text{slope}} \) of Figure 1 goes from 5k\( \Omega \) to 200k\( \Omega \) (see [4] for more details on LM5122 and Experiment 5 to get an insight on the function of the slope compensation resistance). If \( t_{\text{ONmin}} = 300\text{ns} \), the minimum duty-cycle the LM5122 can implement at \( f_s = 500\text{kHz} \) is \( D_{\text{min}} = 0.15 \). If \( V_{\text{in}} = 20\text{V} \) and \( L = 10\mu\text{H} \), based on formula (5) the minimum duty-cycle \( D_{\text{min}} = 0.15 \) corresponds to a load current \( I_{\text{out}} = 225\text{mA} \). If the load demands a current lower than 225mA, the LM5122 controller operating with DEM setup features a skip cycle mode, which periodically maintains the gate driver of MOSFET \( Q_2 \) OFF over a certain number of switching cycles and then restarts the regular switching mode for a certain interval of time. The duration of the skip cycle mode interval increases while the load current decreases. This operation is clearly shown in Figures 10 and 11. The skip cycle mode involves beneficial effects on the efficiency at low load, as the switching losses of the MOSFET \( Q_2 \) are suppressed while suspending the switching operation (see Experiment 2 for further investigations on power losses and efficiency of the boost converter).
Figure 8. DCM steady-state operation (DEM setup):
\[ V_{\text{in}}=10 \text{V}, \: I_{\text{out}}=0.2 \text{A}, \: f_s=250 \text{kHz}, \: L=10 \mu\text{H} \]

Figure 9. CCM steady-state operation (SOM setup):
\[ V_{\text{in}}=10 \text{V}, \: I_{\text{out}}=0.2 \text{A}, \: f_s=250 \text{kHz}, \: L=10 \mu\text{H} \]

Figures 8 and 9 highlight the difference between the waveforms of the LM5122 boost regulator operating in DCM (Figure 8) and in CCM (Figure 9), when the load current \( I_{\text{out}} \) is lower than the threshold current \( I_{\text{dm}} \). You can see that, for the same input voltage \( V_{\text{in}} \), load current \( I_{\text{out}} \), switching frequency \( f_s \) and inductance \( L \), the boost regulator works in DCM with DEM setup and enters the idle interval (dead time) after the inductor current zero crossing. In these conditions, the gate drive of the MOSFET \( Q_1 \) is shut down and its body diode cannot sustain negative current when the MOSFET \( Q_2 \) is turned OFF. When the LM5122 boost regulator operates with SOM setup, the DCM cannot occur, despite of the inductor current zero crossing. In fact, with SOM setup, the gate drive of the MOSFET \( Q_1 \) is switched ON when the MOSFET \( Q_2 \) is turned OFF, and the MOSFET \( Q_1 \) can sustain negative current. Figures 8 and 9 also highlight that the duty-cycle of the boost regulator operating in DCM is lower than the duty cycle of the boost regulator operating in CCM. In fact, in Figure 8 the ON time of the MOSFET \( Q_2 \) determines the duty-cycle \( D=t_{Q2}/f_s \) is shorter than in Figure 9.

[NOTE: The decision about whether to use the DEM or the SOM setup in real world applications can be based on the assessment of which one between the two operation modes provides the best efficiency performance of the converter (see Experiment 2 to get an insight on power losses of the boost regulator with DEM vs SOM)].
Figures 10 and 11 show the waveforms of the LM5122 boost regulator in skip cycle mode, determined by a low load current requiring a duty-cycle smaller than the minimum allowed by the controller. The skip cycle mode is a kind of burst operation. It involves the periodical alternation of two intervals of time, wherein the MOSFET gate driver is activated and de-activated respectively. During the \( t_{\text{skip}} \) interval, the \( Q_2 \) MOSFET gate driver is permanently OFF, so that the inductor is never charged, its current is zero and the body-diode of the \( Q_1 \) MOSFET is reverse biased. In fact, as you can see in the figure 10, the switching node voltage equals the input voltage \( V_{\text{in}} = 20\text{V} \), which is lower than the output voltage \( V_{\text{out}} = 24\text{V} \). Therefore, during the \( t_{\text{skip}} \) interval the current is delivered to the load by the output capacitor, which decreases with a rate \( \frac{dV_{\text{out}}}{dt} = \frac{I_{\text{out}}}{C_{\text{out}}} \). When the output voltage drop exceeds a lower hysteretic threshold \[4\], the \( Q_2 \) MOSFET gate driver is re-activated, and during the \( t_{\text{switch}} \) interval, the controller features the regular switching mode. During this interval the regulator compensates for the charge drop caused in the output capacitor by the skip cycle mode featured in the preceding interval \( t_{\text{skip}} \). When the output voltage rises above an upper hysteretic threshold \[4\], the LM5122 returns into the skip cycle mode, and the sequence repeats periodically. The result is that the output voltage is regulated at the desired average 24V value (as shown by the red traces), with a burst ripple at the frequency \( f_{\text{SC}} = \frac{1}{T_{\text{SC}}} \), where \( T_{\text{SC}} = t_{\text{skip}} + t_{\text{switch}} \). The frequency \( f_{\text{SC}} \) decreases with the load current. Figure 11 is a zoom of Figure 10 and shows the instant of transition from the skip-cycle mode to the switching mode.

[NOTE: The impact of skip-cycle operation on the efficiency at low load can help decide whether to be in DEM or SOM in real world applications]
Experiment 2

The goal of this experiment is to analyze the impact of the operating conditions and of the operation mode on the power losses and efficiency of the boost converter. The LM5122 BOOST regulator is used for this experiment.
The goal of this experiment is to analyze how the efficiency of the boost converter changes with the operating conditions and with the operation mode.

The TI-PMLK LM5122 boost regulator operates with $V_{in} = [9, 20]$V (1), $V_{out} = 24$V, $I_{out} = [0, 2]$A. Fig.1 shows the basic circuit schematic. The power devices highlighted in Fig.1 are: the input capacitor ($C_{in}$), the inductor ($L$), the output capacitor ($C_{out}$), the MOSFETs ($Q_1, Q_2$), the feedback compensation ($R_{fb1, fb2}$), the current slope compensation ($R_{slope}$) and the inductor current sensing resistor ($R_s$). The jumper $J_{16}$ allows to select different operation modes: in Diode Emulation Mode (DEM) operation, $Q_1$ gate is disabled, so $Q_1$ emulates a diode and the boost converter can operate in Discontinuous Conduction Mode (DCM) at low load; in Synchronous Operation Mode (SOM) (2), the $Q_1$ gate is enabled and then the boost converter operates in Continuous Conduction Mode (CCM) at any load. In the Experiment 1 you have investigated the impact of CCM and DCM operation on duty-cycle and conversion ratio. In this experiment the impact of CCM/DCM operation on the boost regulator efficiency is analyzed. Formulae for loss and efficiency calculations in boost regulator are discussed in detail in the Theory Background section.

(1) Restricted range adopted for this educational board, compared to the 4.5V to 65V full range of LM5122 [4]
(2) Also defined Forced PWM Mode [4]

**Test#1.** We measure the power losses of the boost converter for different values of input voltage and load current. The test is realized for given input voltage and load current conditions with different setup of jumper $J_{16}$, which determines the DEM or SOM setup. The DCM is detected by analyzing the inductor current waveform flowing through the current sensing resistor $R_s$ ($R_s$ in the board) whereas the duty-cycle is measured by analyzing the switching node voltage at TEST PIN TP10.

**Test#2.** We analyze the impact of the switching frequency on the efficiency of the boost converter while varying the load current. The test is realized for two different line voltage values and with different setup of jumper $J_{16}$, which determines the switching frequency. The results of the formulae which predict the MOSFET and inductor power losses are compared with measurement results to verify if the relevant trends are consistent.
The losses of power devices in boost converter in DEM and SOM can be analyzed by means of the following simplified formulae (see [1] for more details on boost topology operation and CCM/DCM modeling, [2] for MOSFETs losses calculation, [4] for more details on LM5122 operation and features; refer to Figure 1 to determine inductor and MOSFETs voltages and currents.

**Load current above DCM threshold**

Figure 2 shows the inductor current of a boost converter when \( I_{\text{out}} > I_{\text{dcm}} \), where:

\[
I_{\text{dcm}} = \frac{V_{\text{out}} (M-1)}{2M^2 f_L} \quad M = \frac{V_{\text{out}}}{V_{\text{in}}}
\]

The inductor current slopes, average, peak and valley values are given by:

\[
(2) \quad s_1 = \frac{V_{\text{in}}}{L}, \quad s_2 = \left(\frac{V_{\text{out}}}{V_{\text{in}}}\right)^2
\]

\[
(3) \quad I_{\text{i}} = I_{\text{out}}(1-D_{\text{con}}), \quad D_{\text{con}} = 1-V_{\text{in}}/V_{\text{out}}
\]

\[
(4) \quad I_{\text{i},\text{pk}}(t) = I_{\text{i}} + s_1 D_{\text{con}}(t/2f_L), \quad I_{\text{i},\text{v}}(t) = I_{\text{i}} - s_2 D_{\text{con}}(1-D_{\text{con}})(t/2f_L)
\]

If \( I_{\text{i},\text{pk},\text{dm}}(t) \) is also \( I_{\text{i},\text{v},\text{dm}}(t) < 0 \), the MOSFETs and the inductor cause the main conduction losses, which can be calculated by means of the simplified formulae (5) to (16).

**Inductor winding losses**

\[
P_{\text{sw},\text{Q}} = \frac{1}{2} V_{\text{out}}^2 f_L \left( I_{\text{i}}^2 + I_{\text{pk}}^2\right) + P_{\text{sw},\text{Q}}^{\text{DE}} \quad \text{MOSFET Q\text{. total switching losses}} \]

\[
P_{\text{pk},\text{dm}} = \frac{1}{2} V_{\text{out}} I_{\text{i}} f_L \left( I_{\text{i}}^2 + I_{\text{pk}}^2\right) + P_{\text{pk},\text{dm}} \text{ additional losses}
\]

\[
P_{\text{Q}} = \frac{1}{2} V_{\text{out}} (R_{\text{pk}} + R_{\text{up}}) f_L \quad \text{Q\text{. turn ON}}
\]

\[
P_{\text{Q}} = \frac{1}{2} V_{\text{out}} (R_{\text{pk}} + R_{\text{down}}) f_L \quad \text{Q\text{. turn OFF}}
\]

If \( I_{\text{out}} < I_{\text{dcm}} \), it is also \( I_{\text{i},\text{pk},\text{dm}}(t) > 0 \). The MOSFETs and the inductor cause the main conduction losses, which can be calculated by means of the simplified formulae (5) to (16).

**Load current below DCM threshold**

Figure 3 shows the inductor current of a boost converter when \( I_{\text{out}} < I_{\text{dcm}} \). As DEM involves DCM, the valley current is zero, \( I_{\text{v},\text{dm}} = 0 \), whereas the slopes are the same as in CCM. As SOM prevents the operation in DCM, the formulae of inductor current slopes, average, peak and valley values for the boost converter in SOM operation with \( I_{\text{out}} < I_{\text{dcm}} \) are the same of CCM, with the difference that the valley current is negative, \( I_{\text{v},\text{dm}} < 0 \).

The inductor and MOSFETs losses in SOM are:

\[
P_{\text{pk},\text{dm}} = \frac{1}{2} V_{\text{out}} I_{\text{i}} f_L \left( I_{\text{i}}^2 + I_{\text{pk}}^2\right) + P_{\text{pk},\text{dm}} \text{ additional losses}
\]

\[
P_{\text{Q}} = \frac{1}{2} V_{\text{out}} (R_{\text{pk}} + R_{\text{up}}) f_L \quad \text{Q\text{. turn ON}}
\]

\[
P_{\text{Q}} = \frac{1}{2} V_{\text{out}} (R_{\text{pk}} + R_{\text{down}}) f_L \quad \text{Q\text{. turn OFF}}
\]

The inductor and MOSFETs losses in DEM are:

\[
P_{\text{pk},\text{dm}} = \frac{1}{2} V_{\text{out}} I_{\text{i}} f_L \left( I_{\text{i}}^2 + I_{\text{pk}}^2\right) + P_{\text{pk},\text{dm}} \text{ additional losses}
\]

\[
P_{\text{Q}} = \frac{1}{2} V_{\text{out}} (R_{\text{pk}} + R_{\text{up}}) f_L \quad \text{Q\text{. turn ON}}
\]

\[
P_{\text{Q}} = \frac{1}{2} V_{\text{out}} (R_{\text{pk}} + R_{\text{down}}) f_L \quad \text{Q\text{. turn OFF}}
\]

The inductor and MOSFETs losses in SOM are:

\[
P_{\text{pk},\text{dm}} = \frac{1}{2} V_{\text{out}} I_{\text{i}} f_L \left( I_{\text{i}}^2 + I_{\text{pk}}^2\right) + P_{\text{pk},\text{dm}} \text{ additional losses}
\]

\[
P_{\text{Q}} = \frac{1}{2} V_{\text{out}} (R_{\text{pk}} + R_{\text{up}}) f_L \quad \text{Q\text{. turn ON}}
\]

\[
P_{\text{Q}} = \frac{1}{2} V_{\text{out}} (R_{\text{pk}} + R_{\text{down}}) f_L \quad \text{Q\text{. turn OFF}}
\]
The instruments needed for this experiment are: a DC POWER SUPPLY, four MULTIMETERS, an OSCILLOSCOPE and a DC ELECTRONIC LOAD. Figure 4 shows the instruments connections. Follow the instructions provided in next page to set-up the connections.
Experiment set-up: instructions

With all the instruments turned off, make the following connections:

1) connect the POSITIVE (RED) OUTPUT of the DC POWER SUPPLY to the POSITIVE (RED) CURRENT INPUT of the INPUT CURRENT MULTIMETER (ICM)

2) connect the NEGATIVE (BLACK) CURRENT INPUT of the INPUT CURRENT MULTIMETER (ICM) to the INPUT (VIN) of the J₁₁ screw terminal of the LM5122 boost regulator

3) connect the NEGATIVE (BLACK) OUTPUT of the DC POWER SUPPLY to the GROUND (GND) of the J₁₁ screw terminal of the LM5122 boost regulator

4) connect the OUTPUT (VOUT) of the J₁₂ screw terminal of the LM5122 boost regulator to the POSITIVE (RED) CURRENT INPUT of the OUTPUT CURRENT MULTIMETER (OCM)

5) connect the NEGATIVE (BLACK) CURRENT INPUT of the OUTPUT CURRENT MULTIMETER (OCM) to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD

6) connect the NEGATIVE (BLACK) INPUT of the ELECTRONIC LOAD to the GROUND (GND) of the J₁₂ screw terminal of the LM5122 boost regulator

7) connect the POSITIVE (RED) VOLTAGE INPUT of the INPUT VOLTAGE MULTIMETER (IVM) to the TEST PIN TP₁₁ which is the VIN of the LM5122 boost regulator

8) connect the NEGATIVE (BLACK) VOLTAGE INPUT of the INPUT VOLTAGE MULTIMETER (IVM) to the TEST PIN TP₁₃ which is GND of the LM5122 boost regulator

9) connect the POSITIVE (RED) VOLTAGE INPUT of the OUTPUT VOLTAGE MULTIMETER (OVM) to the TEST PIN TP₁₂ which is VOUT of the LM5122 boost regulator

10) connect the NEGATIVE (BLACK) VOLTAGE INPUT of the OUTPUT VOLTAGE MULTIMETER (OVM) to the TEST PIN TP₁₄ which is GND of the LM5122 boost regulator

11) connect a current probe to channel 1 of the oscilloscope and hang it on the sensing resistor $R_{11}$ of the LM5122 boost regulator, ensuring that the arrow printed on the probe clamps corresponds to the current that enters the inductor (the arrow must point upside when looking the LM5122 boost board frontally, as shown in Figure 6)

12) connect a voltage probe to channel 2 of the oscilloscope and hang it on the TEST PIN TP₁₀ which is the switching node voltage of the LM5122 boost regulator
Test#1: preparation and procedure

Initial jumpers set-up (see Figure 5):
- J13 open → no external synchronization signal connected
- J14 open → low slope current mode compensation
- J15 shorted → switching frequency $f_s = 500\,\text{kHz}$
- J16 open → DEM setup (change to J16 shorted left → SOM setup, according to Measure and Calculate section instructions)
- J16 open, J19 shorted, J20 open → error amplifier gain setup with parts $R_{24}$, $C_{29}$, $C_{34}$ connected
- J23 - J24 shorted → $L_3$ ($10\,\mu\text{H}$) inductor connected

Test Procedure:
1) turn on the MULTIMETERS, set the ICM and the OCM in DC CURRENT MODE, set the IVM and the OVM in DC VOLTAGE MODE
2) turn on the OSCILLOSCOPE, set the CH-1 in DC 50Ω coupling mode, set the CH-2 in DC 1MΩ coupling mode, select CH-2 as trigger source, and execute the “de-gauss” of the current probe to remove possible dc bias in the current probe
3) turn on the POWER SUPPLY (ensure that the OUT ON button is OFF), set the voltage at the initial value of 10V, and set the CURRENT LIMIT > 3A
4) turn on the ELECTRONIC LOAD (ensure that the LOAD ON button is OFF), set the CONSTANT CURRENT MODE, and set the current at 0.2A
5) turn ON the POWER SUPPLY “OUT ON” button and adjust the DC POWER SUPPLY knob until you read 10V in the IVM display. In these conditions you should read about 24V in the OVM display, 0A in the OCM display and a very small positive value in the ICM display (if you do read values different than as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
6) turn ON the ELECTRONIC LOAD ON button and adjust the DC POWER SUPPLY knob until you read 10V in the IVM display. In these conditions you should read about 24V in the OVM display, 0.2A in the OCM display, about 0.5A in the ICM display, and see a triangular waveshape with about 0.5A average value on CH-1 of the OSCILLOSCOPE and a waveform swinging between 24V and a slightly negative value on CH-2 of the OSCILLOSCOPE (if the values are much different than the ones listed above, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY and verify the experiment setup)
7) read the input voltage value on the IVM display, the output voltage value on the OVM display, the input current value on the ICM display, the output current value on the OCM display, measure peak and valley values of the inductor current on CH-1 of the OSCILLOSCOPE, measure the frequency and duty-cycle of the switching node voltage on CH-2 of the OSCILLOSCOPE, detect the operation mode (CCM/DCM) and use the measured values according to Measure and Calculate section instructions. Repeat this step for all the load current and input voltage values listed in Table 1 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button and the ELECTRONIC LOAD “LOAD ON” button while changing the input voltage and the load current)
8) turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, open the jumper J16 to setup LM5122 DEM operation and repeat steps from 3) to 7)
9) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments.
Test#1: measure and calculate

For the operating conditions indicated in Table 1:
1) measure the average input voltage $V_{in}$, input current $I_{in}$, output voltage $V_{out}$, and output current $I_{out}$, the switching frequency $f_s$, the duty-cycle $D$, the peak and valley values $I_p$ and $I_v$ of the inductor current
2) assess whether the regulator operates in CCM or DCM by observing the inductor current (in CCM operation the valley current at the beginning of the switching cycle is positive) (see also Experiment 1)
3) based on the CCM/DCM assessment, and on the DEM/SOM setup, use the appropriate formulae provided in the Theory Background section to calculate the total power losses of the inductor and of the MOSFETs ($P_{DE}$ with SOM setup and $P_{DE}$ DEM setup), then calculate the experimental total power losses $P_{dexp}=V_{in}I_{in}-V_{out}I_{out}$ and fill the Table 1 cells.

Table 1. Efficiency of the boost converter operating at switching frequency $f_s=500kHz$, with $L=10\mu H$, at different line voltage and load current, in DEM and SOM setup

<table>
<thead>
<tr>
<th>$V_{in}$</th>
<th>DEM setup ($J_{16}$ open) $P_{DE}=P_{DE}^{J_{16}}+P_{DE}^{J_{17}}+P_{DE}^{Q_{1}Q_{2}}+P_{DE}^{Q_{3}Q_{4}}$</th>
<th>SOM setup ($J_{16}$ shorted left) $P_{SY}=P_{SY}^{J_{16}}+P_{SY}^{J_{17}}+P_{SY}^{Q_{1}Q_{2}}+P_{SY}^{Q_{3}Q_{4}}+p_{Q_{4}Q_{5}}$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_{in}$=10V</td>
<td>$I_{in}$=0.2A $P_{DE}=P_{DE}^{J_{16}}+P_{DE}^{J_{17}}+P_{DE}^{Q_{1}Q_{2}}+P_{DE}^{Q_{3}Q_{4}}$</td>
<td>$I_{in}$=0.2A $P_{SY}=P_{SY}^{J_{16}}+P_{SY}^{J_{17}}+P_{SY}^{Q_{1}Q_{2}}+P_{SY}^{Q_{3}Q_{4}}+p_{Q_{4}Q_{5}}$</td>
</tr>
<tr>
<td>$V_{in}$=16V</td>
<td>$I_{in}$=0.4A $P_{DE}=P_{DE}^{J_{16}}+P_{DE}^{J_{17}}+P_{DE}^{Q_{1}Q_{2}}+P_{DE}^{Q_{3}Q_{4}}$</td>
<td>$I_{in}$=0.4A $P_{SY}=P_{SY}^{J_{16}}+P_{SY}^{J_{17}}+P_{SY}^{Q_{1}Q_{2}}+P_{SY}^{Q_{3}Q_{4}}+p_{Q_{4}Q_{5}}$</td>
</tr>
</tbody>
</table>

Inductor:

$J_{22}$-$J_{23}$ sh ⇒ $L=L_2=10\mu H$, ESR $= 57$mΩ
$J_{24}$-$J_{25}$ sh ⇒ $L=L_4=3.3\mu H$, ESR $= 19.5$mΩ,

$J_{22}$-$J_{23}$ sh ⇒ $L=L_2=3.3\mu H$, ESR $= 19.5$mΩ,
$J_{24}$-$J_{25}$ sh ⇒ $L=L_4=10\mu H$, ESR $= 57$mΩ
$c_1 = 1.81\cdot10^8$, $c_2 = 5.34\cdot10^{-4}$, $c_3 = 1.28\cdot10^{-4}$, $c_4 = 1.59\cdot10^{-3}$, $c_5 = 376.79$

MOSFETs gate driver (LM5122):

<table>
<thead>
<tr>
<th>$V_{dr}$</th>
<th>$R_{Q1,up}$</th>
<th>$R_{Q1,down}$</th>
<th>$R_{Q2,up}$</th>
<th>$R_{Q2,down}$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_{dr}$=7.6V (min 6.9V, max 8.3V)</td>
<td>$R_{Q1,up}=2.4\Omega$, $R_{Q1,down}=1.8\Omega$</td>
<td>$R_{Q2,up}=2.5\Omega$, $R_{Q2,down}=1.7\Omega$</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

MOSFETs $Q_1$ and $Q_2$:

<table>
<thead>
<tr>
<th>$R_{Q1}$</th>
<th>$Q_{r1}$</th>
<th>$Q_{r2}$</th>
<th>$C_{oss}$</th>
<th>$t_{d1}$</th>
<th>$V_{sd}$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$R_{Q1}$=$12m\Omega(25°C),18m\Omega(125°C)$, $Q_{r1}=4.5nC$, $Q_{r2}=11.5nC$, $V_{sd}=3V(25°C)$, 2.3V(125°C),</td>
<td>$R_{Q1}=5.5\Omega(typ.)$, $11\Omega(max.)$, $g_{fs}=60S(25°C),50S(125°C)$,</td>
<td>$C_{oss}=177pF$, $t_{d1}=80ns$, $V_{sd}=1V$</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Answer:

1) Are the losses at low load with DEM setup higher than with SOM setup?
   - ☐ yes
   - ☐ no
   - ☐ it depends on line voltage
   - ☐ it depends on load current
   - ☐ other: ____________________________________________________________________________________

2) How do the losses change while the input voltage increases?
   - ☐ they increase
   - ☐ they decrease
   - ☐ it depends on load current
   - ☐ it depends on CCM/DCM operation
   - ☐ other: ____________________________________________________________________________________

3) How do the losses change while the load current increases?
   - ☐ they increase
   - ☐ they decrease
   - ☐ it depends on line voltage
   - ☐ it depends on CCM/DCM operation
   - ☐ other: ____________________________________________________________________________________
Test#2: preparation and procedure

Experiment 2

Initial jumpers set-up (see Figure 6):
- J13 open → no external synchronization signal connected
- J14 open → low slope current mode compensation
- J15 open → switching frequency $f_s = 250\text{kHz}$
- J16 shorted left → SOM setup
- J18 open, J19 shorted, J20 open → error amplifier gain setup with parts $R_{24}$, $C_{29}$, $C_{34}$ connected
- J23 - J24 shorted → $L_5 (10\mu\text{H})$ inductor connected

![Figure 6. LM5122 board: jumpers set-up for Test#2](image)

Test Procedure:
1) turn on the MULTIMETERS, set the ICM and the OCM in DC CURRENT MODE, set the IVM and the OVM in DC VOLTAGE MODE
2) turn on the OSCILLOSCOPE, set the CH-1 in DC 50Ω coupling mode, set the CH-2 in DC 1MΩ coupling mode, select CH-2 as trigger source, and execute the "de-gauss" of the current probe to remove possible dc bias in the current probe
3) turn on the POWER SUPPLY (ensure that the OUT ON button is OFF), set the voltage at the initial value of 10V, and set the CURRENT LIMIT $> 3\text{A}$
4) turn on the ELECTRONIC LOAD (ensure that the LOAD ON button is OFF), set the CONSTANT CURRENT MODE, and set the current at 0.2A
5) turn on the POWER SUPPLY "OUT ON" button and adjust the DC POWER SUPPLY knob until you read 10V in the IVM display. In these conditions you should read about 24V in the OVM display, 0A in the OCM display and a very small positive value in the ICM display (if you do read values different than as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
6) turn on the ELECTRONIC LOAD ON button and adjust the DC POWER SUPPLY knob until you read 10V in the IVM display. In these conditions you should read about 24V in the OVM display, 0.2A in the OCM display, about 0.5A in the ICM display, and see a triangular waveshape with about 0.5A average value on CH-1 of the OSCILLOSCOPE and a waveform swinging between 24V and a slightly negative value on CH-2 of the OSCILLOSCOPE (if the values are much different than the ones listed above, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY and verify the experiment setup)
7) read the input voltage value on the IVM display, the output voltage value on the OVM display, the input current value on the ICM display, the output current value on the OCM display, measure peak and valley values of the inductor current on CH-1 of the OSCILLOSCOPE, measure the frequency and duty-cycle of the switching node voltage on CH-2 of the OSCILLOSCOPE, detect the value of the valley inductor current $I_{vl}$ and use the measured values according to Measure and Calculate section instructions. Repeat this step for all the load current and input voltage values listed in Table 2 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button and the ELECTRONIC LOAD “LOAD ON” button while changing the input voltage and the load current)
8) turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, short the jumper $J_{15}$ to setup the switching frequency $f_s = 500\text{kHz}$ and repeat steps from 3) to 7)
9) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments.
Test#2: measure and calculate

For the operating conditions of Table 2:
1) Measure the average input voltage \( V_{in} \), input current \( I_{in} \), output voltage \( V_{out} \) and output current \( I_{out} \), the switching frequency \( f_s \), the duty-cycle \( D \), the peak and valley values \( I_{pk} \) and \( I_{vl} \) of the inductor current
2) Use the formulae provided in the Theory Background section to calculate the inductor conduction losses and core losses (formulae (5) and (6) when \( I_{vl}>0 \), formulae (19) and (6) when \( I_{vl}<0 \)) and the MOSFETs conduction and switching losses (formulae (7), (8) and (13) when \( I_{vl}>0 \), formulae (20), (21), (22) and (23) when \( I_{vl}<0 \)), and write the results in cells (1), (2), (3) and (4) of Table 2
3) Calculate the experimental total power losses \( P_{exp} = P_{in} - P_{out} = V_{in}I_{in} - V_{out}I_{out} \), calculate the efficiency \( \eta_{exp} = P_{out}/(P_{out}+P_{exp}) \) and report the result in cell (5) of Table 2.

Table 2. Efficiency of the boost converter with SOM setup, at \( V_{in} = 10V \) and \( V_{in} = 20V \), with \( f_s = 250kHz \) and \( f_s = 500kHz \)

<table>
<thead>
<tr>
<th>( f_s ) (kHz)</th>
<th>( V_{in} )</th>
<th>( I_{out} )</th>
<th>Load current</th>
</tr>
</thead>
<tbody>
<tr>
<td>250kHz</td>
<td>( V_{in} = 10V )</td>
<td>0.2A</td>
<td>( P_{ind} )</td>
</tr>
<tr>
<td>500kHz</td>
<td>( V_{in} = 20V )</td>
<td>0.4A</td>
<td>( P_{ind} )</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>MOSFETs gate driver (LM5122):</th>
<th>( V_{gs} ) = 7.6V (min 6.9V, max 8.3V)</th>
</tr>
</thead>
<tbody>
<tr>
<td>( R_{Q1,up} )</td>
<td>( 2.4 \Omega )</td>
</tr>
<tr>
<td>( R_{Q1,down} )</td>
<td>( 1.8 \Omega )</td>
</tr>
<tr>
<td>( R_{Q2,up} )</td>
<td>( 2.5 \Omega )</td>
</tr>
<tr>
<td>( R_{Q2,down} )</td>
<td>( 1.7 \Omega )</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Inductor:</th>
<th>( J_{23-24} ) sh ( \rightarrow ) ( L = 10 \mu H, ESR = 57m\Omega )</th>
</tr>
</thead>
<tbody>
<tr>
<td>( c_1 )</td>
<td>( 1.81 \times 10^8 )</td>
</tr>
<tr>
<td>( c_2 )</td>
<td>( 5.34 \times 10^5 )</td>
</tr>
<tr>
<td>( c_3 )</td>
<td>( 1.28 \times 10^4 )</td>
</tr>
<tr>
<td>( c_4 )</td>
<td>( 1.59 \times 10^{-9} )</td>
</tr>
<tr>
<td>( c_5 )</td>
<td>( 376.79 )</td>
</tr>
</tbody>
</table>

| MOSFETs \( Q_1 \) and \( Q_2 \): | \( R_{gs} = 12m\Omega (25^\circC), 18m\Omega (125^\circC), Q_{g_s} = 4.5nC, Q_{gs} = 11.5nC, Q_{gs} = 54nC, V_{gs} = 3V (25^\circC), 2.3V (125^\circC), R_{gs} = 5.5\Omega (typ.), 113\Omega (max), g_{fs} = 40S (25^\circC), 50S (125^\circC), C_{gs} = 177pF, g_{fs} = 80ns, V_{gs} = 1V \) |

Answer:

1. How do the calculated inductor and MOSFETs losses change while the switching frequency increases?
   - Inductor: conduction: they increase, they decrease, it depends on the load current, it depends on the input voltage
   - MOSFETs: conduction: they increase, they decrease, it depends on the load current, it depends on the input voltage

2. How do the total MOSFET+inductor calculated losses change while the switching frequency increases?
   - they increase, they decrease, it depends on the load current, it depends on the input voltage

3. How does the measured efficiency change while the switching frequency increases?
   - it increases, it decreases, it depends on the load current, it depends on the input voltage
Experiment 2

The **Theory Background** section highlights that the power loss of the boost depends on the input voltage \( V_{in} \), the switching frequency \( f_s \), the load current, and the inductance \( L \). With DEM setup the boost converter operates with the diodes of the MOSFET Q1 as freewheeling diodes, and then it can operate in DCM or in CCM depending on the load current. In particular, the DCM can be observed when the load current \( I_{load} \) is lower than the value of the threshold current \( I_{th} \) given by equation (1) of the **Theory Background** section. With SOM setup, instead, the boostconverter operates in CCM for whatever load current, as the MOSFET Q1 can sustain negative currents when it is ON. With SOM setup, when the load current is lower than the threshold current \( I_{th} \) at the beginning of the switching cycle, where the MOSFET Q1 turns OFF and the MOSFET Q2 turns ON, negative \( I_{dl} < 0 \) and this causes a change in the conduction and switching losses of both MOSFETs. Therefore, as highlighted in **Theory Background** section, we have four possible operation mode combinations one involving the DCM: DEM with \( I_{load} > I_{th} \), SOM with \( I_{load} > I_{th} \) (CCM), SOM with \( I_{load} < I_{th} \) (CCM). The DCM influences the shape of the inductor current, which remains at zero during the dead interval (see the discussion of Experiment 1 on the real behavior of inductor current and switching node voltage in DCM), whereas there is no dead interval in CCM. This is why we have the two different formulae for inductor winding losses (5) and (19) for CCM and DCM respectively. The conduction and switching losses of MOSFETs are different when the boost converter operates in DCM. In fact, due to the different values of peak and valley of the inductor currents \( I_{in} \) and \( I_L \), the rms currents change, and the turn ON commutation of MOSFET Q2 changes too, as it occurs at zero current with consequent zero losses. When the load current \( I_{load} \) is higher than the value of the threshold current \( I_{th} \), the inductor current waveforms with DEM and SOM are the same. However, the conduction losses are different because with DEM setup the body diode of the MOSFET Q1 conducts during the entire interval from the turn OFF of the MOSFET Q1 to its following turn ON, whereas with SOM setup it conducts only during the short dead time \( t_d \) needed to avoid the cross-conduction of the two MOSFETs.

In Test#2 we are interested in analyzing the impact of the switching frequency on inductor and MOSFETs losses and on the efficiency of the boost converter while varying the load current. The SOM is preferred in dc-dc converters operating with high load current, as it facilitates the achievement of higher efficiency, thanks to the reduced conduction losses of power MOSFETs compared to diodes. The boost regulator with SOM setup operates in CCM, regardless of whether the load current \( I_{load} \) is lower or higher than the value of the threshold current \( I_{th} \) given by equation (1) of the **Theory Background** section (see Experiment 1 to further investigate the operation in DCM). Nevertheless, the operation with a load current lower than the threshold current \( I_{th} \) (which involves \( I_{dl} < 0 \)) determines different losses in the two MOSFETs and in the inductor, which are the devices determining the main contributions to the converter power losses. The MOSFETs and inductor conduction losses increase as the square of the rms current are proportional to the drain-to-source resistance in the MOSFETs and to the winding resistance in the inductor. Conduction losses formulae (5), (7) and (8) are valid when \( I_{dl} > 0 \) \( (I_{dl} > I_{th}) \), whereas the formulae (19), (20) and (21) are valid when \( I_{dl} < 0 \) \( (I_{dl} < I_{th}) \). The formulae for the calculation of MOSFETs switching losses when \( I_{dl} < 0 \) are different than the ones provided for the case \( I_{dl} > 0 \) too, although the boost regulator operates in CCM in both situations. The MOSFETs switching losses occur during the turn ON and during the turn OFF, while the devices transit through the saturation region, where they sink the power \( V_{ds} I_{ds} \). MOSFETs switching losses are given by the formula (13) when \( I_{dl} > 0 \) \( (I_{dl} > I_{th}) \), whereas the formula (22) is valid when \( I_{dl} < 0 \) \( (I_{dl} < I_{th}) \). When \( I_{dl} > 0 \), the switching losses are mostly determined by the turn ON and the turn OFF of the MOSFET Q2 in hard-switching mode (formula (13)), namely with drain-to-source voltage \( V_{ds} \) \( \neq 0 \) and current \( I_{ds} \) \( \neq 0 \) at the instant of commutation and with a large swing of the \( V_{ds} \) voltage from \( V_{ds} \) to zero at the turn ON and from zero to \( V_{ds} \) at the turn OFF. The MOSFET Q1, instead, turns ON and OFF in soft-switching mode, while its body diode conducts, thus clamping the \( V_{ds} \) voltage to its forward voltage value (about 1V) during the commutations. This reduces dramatically the switching losses (this is why they are neglected). When \( I_{dl} < 0 \), the switching losses are determined by both MOSFETs at their turn OFF in hard-switching mode (formula (22)), whereas both MOSFETs turn ON in soft-switching mode, with very small losses, as such commutation occurs while their own body diode are conducting, respectively. The simple rule to assess whether a MOSFET is turning ON or OFF in hard-switching or in soft-switching is that the commutation occurs in hard-switching if the drain-to-source current \( I_{ds} \) at the moment of the commutation is positive, and in soft-switching if the drain-to-source current \( I_{ds} \) is negative. Overall, the MOSFETs switching losses are proportional to the switching frequency, as the amount of energy lost because of switching losses per each switching period is fixed, and then the average switching losses increase with the switching frequency. Inductor core losses are determined by the hysteresis and by the eddy currents phenomena affecting the magnetic core, and are given by the formula (6). While the MOSFETs switching losses can be quite easily determined from physical models, which lead to the relevant loss formulae referred above, the inductor core losses formulae are derived experimentally by the manufacturers, through a curve fitting of experimental measurements of power losses. Inductor core losses may depend on the switching frequency in a quite involved way (note that the \( \gamma \) factor in formula (6) is proportional to the peak-to-peak ripple \( \Delta I_{ds} \) and then inversely proportional to the switching frequency).
The plots collected in the Figures 7 to 10 show the waveforms of the boost converter in CCM and DCM operation.

The plot of Figure 7 shows the DCM operation at low load current determined by the DEM setup. In theory, the valley current $I_{v,\text{dm}}$ should be zero. Due to the oscillations caused by the resonance between the MOSFETs parasitic capacitances and the inductor, during the dead interval the inductor current swings around zero. This determines a slight increase of inductor conduction and core losses. Figure 8 shows the CCM operation, in the same test conditions of Figure 7, determined by the SOM setup. Now, there is no dead interval and the inductor current waveform is purely triangular, with a negative valley current $I_{v,\text{cm}}$. You can observe that the peak inductor currents $I_{v,\text{dm}}$ and $I_{v,\text{cm}}$ and the MOSFET $Q_2$ ON times $t_{Q2,\text{dm}}$, $t_{Q2,\text{cm}}$ are different.

[NOTE: the real switching frequency is about 265kHz. This is the value to be used in the theoretical power loss formulae provided the Theory Background section to calculate the inductor core losses and the MOSFETs switching losses].
The plots of Figures 9 and 10 show the impact of the switching frequency on the inductor current waveform. Doubling the switching frequency reduces the inductor peak-to-peak ripple current of about 50% and makes the valley current $I_{vl}$ positive. It is expected that the effects of the higher magnitude of the peak-to-peak inductor current ripple of Figure 9 on the inductor core losses can be balanced by the effects of the lower switching frequency, based on the loss formula (6) provided in the Theory Background section. It is also expected that in case of Figure 9 the turn ON losses of MOSFET $Q_2$ are negligible, as it commutates in soft-switching mode, and that the turn OFF losses of the MOSFET $Q_2$ are also small, despite of the hard-switching commutation, due to the small magnitude of the inductor current at the instant of commutation. In the case of Figure 10, instead, the switching losses are concentrated in the MOSFET $Q_2$, as both its commutations are in hard-switching mode.

[NOTE: the real switching frequency values are about 265kHz and 513kHz, in Figures 9 and 10 respectively. These are the values to be used in the theoretical power loss formulae provided in the Theory Background section to calculate the inductor core losses and the MOSFETs switching losses].
Experiment 3

The goal of this experiment is to analyze the influence of input voltage, load current and feedback compensation on the dynamic response of a current-mode controlled boost converter. The TPS55340 boost regulator is used for this experiment.
The goal of this experiment is to analyze the influence of input voltage, load current and feedback compensation on the dynamic response of current-mode controlled boost converter.

Test#1. We set-up the TPS55340 boost regulator with different input voltage values and observe the output voltage waveform as the load current swings between two fixed levels. The expectation is that, after each load current change, the output voltage has some transient surge and then it returns to the nominal value. The magnitude of the output voltage transient surges will be measured. The influence of the output capacitance $C_{\text{OUT}}$ and of the feedback compensation setup on the magnitude of voltage transient surges will be observed and discussed.

Test#2. We set-up the TPS55340 boost regulator with different load current values and observe the output voltage waveform as the input voltage swings between two fixed levels. The expectation is that, after each input voltage change, the output voltage has some transient surge and then it returns to the nominal value. The magnitude of the output voltage transient surges will be measured. The influence of the output capacitance $C_{\text{OUT}}$ and of the feedback compensation setup on the magnitude of voltage transient surges will be observed and discussed.
Uncompensated Loop Gain
The control-to-output gain of peak-current-mode controlled boost converter is (1):

\[ G_{vc}(s) = G_{ac} \frac{1 + \frac{s}{\omega_{ac}}}{1 + \frac{s}{\omega_{w}}} \left[ 1 - \frac{s}{\omega_{w}} \right] \]

where \( \omega_{ac} = 2\pi f_c \) and:

(2) \( G_{ac} = \frac{V_s}{2f_c R_s} \); \( \omega_{ac} = \frac{1}{ESR_{out} C_{out}} \);

(3) \( \omega_{w} = \frac{V_s}{V_{out}} \); \( \omega_{w} = \frac{1}{C_{out} V_{out}} \);

(4) \( Q_s = \frac{1}{\pi} \left( \frac{V_s}{V_{out}} \left( 1 + \frac{S}{s} \right) - \frac{1}{2} \right) \); \( \frac{V_s}{V_{out}} \)

(5) \( s = K_s + K_v \); \( s = \frac{R V_v}{L} = K V_v \)

(6) \( V_{out} = \frac{K_v}{2} \left( \frac{K_v}{K} \right) < \frac{V_{out}}{2} + 2 \left( \frac{K_v}{K} \right) \)

Figure 3 shows how the DC gain \( G_{vc} \) of the Low Frequency Pole \( \omega_{ac} \), the Right Half Plane zero \( \omega_{w} \), and the sampling quality factor \( Q_s \) of peak-current-mode control change with \( V_{out} \) and \( I_{out} \).

Error Amplifier Gain
Figure 4 shows the circuit setup of the TPS55340 Type II Error Amplifier (EA).

The EA gain \( G_c(s) \) determines the compensated loop gain \( T(s) = G_{vc}(s)G_c(s) \). For Type II EA it is:

(7) \( G_c(s) = G_{vc}(1 + \frac{s}{\omega_{ac}})^{-1} \)

(8) \( \frac{R_{ea} + R_{sh}}{R_{ea} + R_{sh}} = H = \frac{V_{out}}{V_{out}} \) \( G_{ea} = \frac{R_{ea} G_c H}{s} \)

(9) \( \omega_z = \frac{1}{R_{ea} C_c} \) \( \omega_{p0} = \frac{1}{R_{ea} (C_a + C_c + C_e)} \)

(10) \( \omega_{p} = \frac{1}{(R_{ea} R_{sh}) (C_a + C_c + C_e)} \)

The parameters of the external impedances \( Z \) (\( R_{sh} \)) and \( Z \) (\( R_c, C_c, C_e \)) depend on the desired cross-over frequency \( \omega_c \) and phase margin \( \varphi_c \) of the compensated loop gain \( T(s) \), according to the following formulae [3]:

(11) \( C_c = K \frac{\varphi_c - K - 1}{R_{ea} (K^2 + 1)} \) \( C_e = \frac{R_{ea} - C_c - C_e}{\varphi_b} \)

(12) \( R_c = \frac{K}{\varphi_c - \varphi_b} \) \( K = \tan[\frac{1}{2} \varphi_c + 45^\circ] \)

(13) \( \gamma_c = \frac{1}{\omega_c} \sqrt{\left[ \frac{G_c}{G_{vc} K} \right]^2 - 1} \)

(14) \( \varphi_b = \varphi_c - 90^\circ - \angle G_{vc}(\omega_c) \)

(15) \( |G_{vc}(\omega_c)| = \text{magnitude of } G_{vc}(\omega_c) @ \omega_c = \varphi_c \)

(16) \( \angle G_{vc}(\omega_c) = \text{phase of } G_{vc}(\omega_c) @ \omega_c = \varphi_c \)

Figure 5 shows the Bode plots of the control-to-output \( G_{vc} \) gain at \( V_{min} = 5V \) and \( V_{max} = 12V \), and highlights the maximum cross-over frequency \( \omega_{c,max} \) allowing the use of a Type II EA.

Good to Know
- The maximum cross-over frequency allowed by Type II EA, \( \omega_{c,max} \), is where \( \varphi_b = 90^\circ \). Beyond that limit a phase boost \( \varphi_b > 90^\circ \) is required and a Type III EA is needed, which is characterized by two zeros and two poles. \( R_{ea} \) limits the maximum DC gain \( G_{vc} \); \( C_a \) limits the maximum cross-over frequency \( \omega_c \).
The instruments needed for this experiment are: a POWER SUPPLY with DC and DYNAMIC MODE options, an ELECTRONIC LOAD with DC and DYNAMIC MODE options and an OSCILLOSCOPE. Figure 5 shows the instruments connections. Follow the instructions provided in next page to set-up the connections.

Figure 6. Experiment set-up.

WARNING!
Keep the wires 3) and 4) as short as possible to limit the parasitic inductance.
With all the instruments turned off, make the following connections:

1) connect the POSITIVE (RED) OUTPUT of the DC POWER SUPPLY to the INPUT (VIN) of the J4 screw terminal of the TPS55340 boost regulator

2) connect the NEGATIVE (BLACK) OUTPUT of the DC POWER SUPPLY to the GROUND (GND) of the J4 screw terminal of the TPS55340 boost regulator

3) connect the OUTPUT (VOUT) of the J3 screw terminal of the TPS55340 boost regulator to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD

4) connect the GROUND (GND) of the J3 screw terminal of the TPS55340 boost regulator to the NEGATIVE (BLACK) INPUT of the ELECTRONIC LOAD

5) connect a current probe to channel 1 of the OSCILLOSCOPE and hang it on the cable connecting the OUTPUT (VOUT) of the J3 screw terminal of the TPS55340 boost regulator to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD, ensuring that the arrow printed on the probe clamps corresponds to the current that enters the ELECTRONIC LOAD

6) connect a voltage probe to channel 2 of the OSCILLOSCOPE, hang its positive tip to TEST PIN TP4 which is the output voltage of the TPS55340 boost regulator. This probe will be used to measure the DC+AC components of the output voltage
   [WARNING: DO NOT INVERT the positive and ground connections of the voltage probe]

7) connect a voltage probe to channel 3 of the OSCILLOSCOPE, hang its positive tip to TEST PIN TP4 which is the output voltage of the TPS55340 boost regulator. This probe will be used to measure the AC component of the output voltage
   [WARNING: DO NOT INVERT the positive and ground connections of the voltage probe]

8) connect a voltage probe to channel 4 of the OSCILLOSCOPE, hang its positive tip to TEST PIN TP3 which is the input voltage of the TPS55340 boost regulator
   [WARNING: DO NOT INVERT the positive and ground connections of the voltage probe]
**Test Procedure:**

1. Turn on the OSCILLOSCOPE, set CH-1 in DC 50Ω coupling mode, select CH-1 as trigger source, and execute the “de-gauss” of the current probe to remove possible DC bias in the current probe. Set CH-2 in DC 1MΩ coupling mode, CH-3 in AC 1MΩ coupling mode, and CH-4 in DC 1MΩ coupling mode.
2. Turn on the POWER SUPPLY (ensure that the “OUT ON” button is OFF), set the DC VOLTAGE at 5V, and set the CURRENT LIMIT at 2.5A.
3. Turn on the ELECTRONIC LOAD (ensure that the “LOAD ON” button is OFF), set the DYNAMIC CURRENT MODE and fix the low current level at 200mA for 800µs, the high current level at 400mA for 800µs, the current rise and fall slew-rates at the highest level allowed by the instrument, and turn ON the POWER SUPPLY “OUT ON” button. In these conditions you should see the load current on the CH-1 trace of the OSCILLOSCOPE as a flat waveform at zero level, the DC+AC components of the output voltage on the CH-2 trace as a flat waveform at 24V average value, the AC component of output voltage on CH-3 trace as a flat waveform at zero level, and the input voltage on CH-4 trace as a flat line at 5V level (if the waveforms do not look as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps).
4. Turn on the ELECTRONIC “LOAD ON” button. In these conditions you should see the load current on the CH-1 trace of the OSCILLOSCOPE as square-wave between 0.2A and 0.4A, the DC+AC components of the output voltage on the CH-2 trace as a waveform with 24V average value with small positive and negative surges at the instants of the load current steps, the AC component of output voltage on CH-3 trace as a flat waveform at zero level with small positive and negative surges at the instants of the load current steps, and the input voltage on CH-4 trace as a flat line at 5V level (if the waveforms do not look as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps).
5. Record in Table 1 the magnitude of the output voltage surges after each load transient for the input voltage values listed in Table 1 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button while adjusting the input voltage).
6. Turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then open the jumper J2 to disconnect the C5 (4.7µF) output capacitor, repeat the steps 4) to 6), and report the results in Table 1.
7. Turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then open the jumper J1 to disconnect the C5 (4.7µF) output capacitor, repeat the steps 4) to 6), and report the results in Table 1.
8. Turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then short the jumper J7 on right side to connect the R8, C9, C11 parts to the error amplifier, repeat the steps 4) to 6), and report the results in Table 1.
9. At the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments.
Test#1: measure and calculate

For the operating conditions of Table 1, measure the peak output voltage overshoot and undershoot, with a dynamic load connected to the output.

Table 1. Load transient overshoot and undershoot magnitude of TPS55340 boost regulator at \( f_s = 400\text{kHz} \) with \( L = 10\mu\text{H} \) for different input voltage values

<table>
<thead>
<tr>
<th>( V_{\text{in}} )</th>
<th>( \Delta V_{\text{out}} )</th>
<th>( I_{\text{out}} )</th>
<th>( I_{\text{out}} )</th>
<th>( \Delta V_{\text{out}} )</th>
<th>( I_{\text{out}} )</th>
<th>( I_{\text{out}} )</th>
<th>( \Delta V_{\text{out}} )</th>
<th>( I_{\text{out}} )</th>
<th>( I_{\text{out}} )</th>
</tr>
</thead>
<tbody>
<tr>
<td>5V</td>
<td>( 3 \times 4.7\mu\text{F} )</td>
<td>( R_7 ), ( C_{10} ) connected</td>
<td>( 0.2\text{A} \rightarrow 0.4\text{A} )</td>
<td>( 0.4\text{A} \rightarrow 0.2\text{A} )</td>
<td>( 2 \times 4.7\mu\text{F} )</td>
<td>( R_7 ), ( C_{10} ) connected</td>
<td>( 0.2\text{A} \rightarrow 0.4\text{A} )</td>
<td>( 0.4\text{A} \rightarrow 0.2\text{A} )</td>
<td>( 2 \times 4.7\mu\text{F} )</td>
</tr>
<tr>
<td>8V</td>
<td>( 3 \times 4.7\mu\text{F} )</td>
<td>( R_7 ), ( C_{10} ) connected</td>
<td>( 0.2\text{A} \rightarrow 0.4\text{A} )</td>
<td>( 0.4\text{A} \rightarrow 0.2\text{A} )</td>
<td>( 2 \times 4.7\mu\text{F} )</td>
<td>( R_7 ), ( C_{10} ) connected</td>
<td>( 0.2\text{A} \rightarrow 0.4\text{A} )</td>
<td>( 0.4\text{A} \rightarrow 0.2\text{A} )</td>
<td>( 2 \times 4.7\mu\text{F} )</td>
</tr>
<tr>
<td>12V</td>
<td>( 3 \times 4.7\mu\text{F} )</td>
<td>( R_7 ), ( C_{10} ) connected</td>
<td>( 0.2\text{A} \rightarrow 0.4\text{A} )</td>
<td>( 0.4\text{A} \rightarrow 0.2\text{A} )</td>
<td>( 2 \times 4.7\mu\text{F} )</td>
<td>( R_7 ), ( C_{10} ) connected</td>
<td>( 0.2\text{A} \rightarrow 0.4\text{A} )</td>
<td>( 0.4\text{A} \rightarrow 0.2\text{A} )</td>
<td>( 2 \times 4.7\mu\text{F} )</td>
</tr>
</tbody>
</table>

Feedback compensation components:
- \( J_7 \) sh left: \( R_c = R_7 = 976\Omega, \, C_c = C_{10} = 150\text{nF}, \, C_s = C_{8} = 68\text{nF} \) \( \left[ f_c = 1.5\text{kHz}, \phi_c = 45^\circ \right] \) \( \text{O.C.} \)\(^{(5)}\)
- \( J_7 \) sh right: \( R_c = R_8 = 2.37\text{k}\Omega, \, C_c = C_{11} = 470\text{nF}, \, C_s = C_{9} = 220\text{pF} \) \( \left[ f_c = 6.5\text{kHz}, \phi_c = 45^\circ \right] \) \( \text{O.C.} \)\(^{(5)}\)

\(^{(5)}\) Operating Conditions (O.C.): \( V_{\text{in}} = 5\text{V}, \, I_{\text{out}} = 1.2\text{A}, \, L = 10\mu\text{H} \), \( C_{\text{out}} = 3 \times 4.7\mu\text{F} \)

Inductor
- \( J_7 \) sh: \( L = L_1 = 10\mu\text{H} \)
- \( J_7 \) sh: \( L = L_2 = 3.3\mu\text{H} \)

Output capacitor:
- \( J_7 \) op: \( C_{\text{out}} = 2 \times 4.7\mu\text{F} \)
- \( J_7 \) sh: \( C_{\text{out}} = 3 \times 4.7\mu\text{F} \)

Answer:
1. Is the load transient voltage overshoot magnitude bigger than the undershoot magnitude?  
   - \( \square \) yes  \( \square \) no  \( \square \) it depends on line voltage
2. Is the load transient response characterized by oscillations?  
   - \( \square \) yes  \( \square \) no  \( \square \) it depends on line voltage
3. How does the load transient surge magnitude change when the line voltage increases?  
   - \( \square \) it increases with voltage  \( \square \) it decreases with voltage  \( \square \) it is not correlated
4. What is the factor determining the strongest change in the load transient surge magnitude?  
   - \( \square \) the output capacitor  \( \square \) the compensation  \( \square \) they are equivalent
Test#2: preparation and procedure

Initial jumpers set-up (see Figure 8):

- **J6** shorted left → boost operation enabled
- **J2** shorted → C5 (4.7 µF) output capacitor connected
- **J7** shorted right → switching frequency \( f_s = 400\text{kHz} \)
- **J4** shorted left → error amplifier gain setup with parts \( R_7, C_8, C_{10} \) connected (lower cross-over frequency)
- **J1 - J5** shorted → L1 (10 µH) inductor connected
- **J21 - J22** shorted → loss emulation resistor \( R_1 \) bypassed
- **J6** open → boost operation with internal synchronization

Test Procedure:

1) turn on the OSCILLOSCOPE, set CH-1 in DC 50Ω coupling mode, select CH-1 as trigger source, execute the “de-gauss” of the current probe to remove possible dc bias in the current probe, set CH-2 in DC 1MΩ coupling mode, CH-3 in AC 1MΩ coupling mode and CH-4 in DC 1MΩ coupling mode
2) turn on the POWER SUPPLY (ensure that the “OUT ON” button is OFF), set the DYNAMIC MODE, fix the low voltage level at 5V for 800µs, the high voltage level at 12V for 800µs, the voltage rise and fall slew-rates at the highest level allowed by the instrument, the CURRENT LIMIT at 3.5A
3) turn on the ELECTRONIC LOAD (ensure that the “LOAD ON” button is OFF), set the DC CURRENT MODE and current level at 200mA
4) turn ON the POWER SUPPLY “OUT ON” button. In these conditions you should see the load current on the CH-1 trace of the OSCILLOSCOPE as a flat waveform at zero level, the DC+AC components of the output voltage on the CH-2 trace as a flat waveform at 24V average value with small positive and negative surges at the instants of the line voltage steps, the AC component of output voltage on CH-3 trace as a flat waveform at zero leve with small positive and negative surges at the instants of the line voltage steps, and the input voltage on CH-4 trace as a square-wave between 5V and 12V (if the waveforms do not look as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
5) turn ON the ELECTRONIC “LOAD ON” button. In these conditions you should see the load current on the CH-1 trace of the OSCILLOSCOPE as a flat waveform at 200mA average level with small positive and negative surges at the instants of the line voltage steps, the DC+AC components of the output voltage on the CH-2 trace as a waveform with 24V average value with small positive and negative surges at the instants of the load current steps, the AC component of output voltage on CH-3 trace as a flat waveform at zero level with small positive and negative surges at the instants of the load current steps, and the input voltage on CH-4 trace as a flat line at 5V level (if the waveforms do not look as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
6) record in Table 1 the magnitude of the output voltage surges after each line transient for the load current values listed in Table 1 (you do not need to turn OFF the ELECTRONIC LOAD “LOAD ON” button while adjusting the load current)
7) turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then open the jumper \( J_4 \) to disconnect the \( C_5 \) (4.7 µF) output capacitor, repeat the steps 4) to 6), and report the results in Table 1
8) turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then short the jumper \( J_4 \) on right side to connect the \( R_8, C_9, C_{11} \) parts to the error amplifier, repeat the steps 4) to 6), and report the results in Table 1
9) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments
Test#2: measure and calculate

For the operating conditions of Table 2, measure the peak output voltage overshoot and undershoot, with a dynamic source connected to the input.

Table 2. Line transient overshoot and undershoot magnitude of TPS55340 boost regulator at \( f_s = 400\text{kHz} \) with \( L = 10\mu\text{H} \) for different load current values.

<table>
<thead>
<tr>
<th>( \Delta V_{\text{out}} )</th>
<th>( V_{\text{in}} )</th>
<th>( V_{\text{out}} )</th>
<th>( \Delta V_{\text{out}} )</th>
<th>( V_{\text{in}} )</th>
<th>( V_{\text{out}} )</th>
<th>( \Delta V_{\text{out}} )</th>
<th>( V_{\text{in}} )</th>
<th>( V_{\text{out}} )</th>
</tr>
</thead>
<tbody>
<tr>
<td>(-0.2\text{A})</td>
<td>5V\rightarrow12V</td>
<td>12V\rightarrow5V</td>
<td>(-0.2\text{A})</td>
<td>5V\rightarrow12V</td>
<td>12V\rightarrow5V</td>
<td>(-0.2\text{A})</td>
<td>5V\rightarrow12V</td>
<td>12V\rightarrow5V</td>
</tr>
<tr>
<td>(-0.4\text{A})</td>
<td></td>
<td></td>
<td>(-0.4\text{A})</td>
<td></td>
<td></td>
<td>(-0.4\text{A})</td>
<td></td>
<td></td>
</tr>
<tr>
<td>(-0.6\text{A})</td>
<td></td>
<td></td>
<td>(-0.6\text{A})</td>
<td></td>
<td></td>
<td>(-0.6\text{A})</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Answer:

1. Is the line transient voltage overshoot magnitude bigger than the undershoot magnitude?  
   - yes  
   - no  
   - it depends on load current

2. Is the line transient response characterized by oscillations?  
   - yes  
   - no  
   - it depends on load current

3. How does the line transient surge magnitude change when the load current increases?  
   - it increases with current  
   - it decreases with current  
   - it is not correlated

4. What is the factor determining the strongest change in the line transient surge magnitude?  
   - the output capacitor  
   - the compensation  
   - they are equivalent
In Test#1 we are interested in investigating correlations among the load transient response of the boost regulator, the line voltage and the setup of output capacitor and feedback compensation. A voltage regulator with a good load transient response yields a small output voltage surge when the load current suddenly steps up or steps down. Typical specifications for real-world dc-dc power supplies require that the load transient surges are limited within about ±5% of the average output nominal voltage. A simple concept can be applied to quickly assess the impact of any physical or operating parameter on the load transient performance of a voltage regulator: the magnitude of load transient surges decreases if the voltage loop cross-over frequency increases. In fact, a higher cross-over frequency improves the reactivity of the control voltage $v_c$ (see Figures 1 and 2) to load changes. This results in a faster response of the inductor current to the load demand, thus shortening the duration of the time interval wherein the output capacitor has to sustain the unbalance between the inductor current and the load current (see the TI-PMLK BUCK Experiment Book and Ti-PMLK LDO Experiment Book). The cross-over frequency and the load transient response of a peak-current controller boost regulator are influenced by three main elements: (a) the inherent dynamic properties of the boost topology, (b) the setup of the peak current control loop, and (c) the setup of the voltage feedback compensation. The combination of these elements determines the capability of the boost regulator to reject the effects of a load perturbation on the output voltage. Regarding the point (a), formulae (1) to (5) allow the analysis of the impact of input voltage and output capacitor. In particular, a higher input voltage involves a higher DC gain $G_{vc0}$ and a higher RHP frequency $\omega_{\text{RHP}}$. The resulting combined effect is that, for a given EA setup, a higher input voltage results in a higher cross-over frequency, as shown in Figure 5 of the Theory Background section, and then a better load transient performance (see the TI-PMLK BUCK Experiment Book to assess the difference between the peak current mode controlled buck and boost regulators). The output capacitor setup with $3 \times 4.7 \mu F$ identical capacitors does not change the ESR frequency $\omega_{\text{ESR}}$ given in formula (2), whereas the LFP frequency $\omega_{\text{LFP}}$ decreases when the output capacitance $C_{\text{out}}$ increases. This results in a decrease of the crossover frequency. Nevertheless, the higher capacitance can balance the decrease of the cross-over frequency, as it can sustain for a longer time the unbalance between the inductor current and the load current. Overall, the two setup $3 \times 4.7 \mu F$ or $2 \times 4.7 \mu F$ should not make a significant difference in load transient performance. The impact of the peak current control loop setup on load transient performance can be understood by means of formulae (1) and (4). Whatever element yields and increase of the quality factor $Q_c$ determines an increase of the control-to-output gain and therefore a better load transient performance. The plot of Figure 3 highlights that $Q_c$ increases with the input voltage, in the range of operation of the TPS55340. An EA designed to achieve a higher crossover frequency determines an improvement of the load transient performance.

[NOTE: Given the voltage loop gain $T$, the cross-over frequency $\omega_c$ is the frequency such that the loop gain magnitude equals 1, that is $|T(\omega_c)|=1$. An explicit formula for $\omega_c$ is not available. The cross-over frequency $\omega_c$ can be determined by means of MATLAB® [8]. If the loop gain transfer function $T$ is not available, it can be measured by means of a network vector analyzer [9] using the 10Ω injection resistor $R_s$ mounted in the TPS55340 board]

In Test#2 we are interested in investigating correlations among the line transient response of the boost regulator, the load current and the setup of output capacitor and feedback compensation. A voltage regulator with a good line transient response yields a small output voltage surge when the line voltage suddenly steps up or steps down. Typical specifications for real-world dc-dc power supplies require that the line transient surges are limited within about ±5% of the average output nominal voltage. The correlation of line transient response with the output capacitor and voltage feedback compensation is the same discussed above for the load transient. The inherent feedforward action implemented by the peak current control modulator, shown in Figure 2, has a big influence on the line transient response of the peak current controlled boost regulator. In particular, as the slope $S_c$ of the current signal is inversely proportional to the input voltage, the duty-cycle $D$ is promptly adjusted with change in input voltage. The level of the control signal $v_c$, in fact, is mainly determined by the load current demand. So that, for a given load current, if a line transient occurs, the control signal $v_c$ is kept temporarily fixed by the voltage error-amplifier, while the PWM comparator changes the duty-cycle $D$ instantaneously. Eventually, the control signal $v_c$ value is finely adjusted by the voltage error amplifier. The line transient performance of a peak current controlled boost regulator is then mainly determined by the feedforward action discussed above. Best performances are achieved when the ratio $S_c/S_n$ of formula (4) is small. But, a very small ratio $S_c/S_n$ may lead to instability if $Q_c$ (which depends on the input voltage) becomes negative.
The plots collected in the Figures 9 to 12 show some examples of load and line transient response of the TPS55340 boost regulator.

Figure 9. TPS55340 boost regulator load transient response with R_7, C_8, C_{10} connected (lower cross-over frequency): V_\text{in}=12V, I_{\text{out}}=0.2A to 0.4A, f_s=400kHz, L=10\mu H

Figure 10. TPS55340 boost regulator load transient response R_8, C_9, C_{11} connected (higher cross-over frequency): V_\text{in}=5V, I_{\text{out}}=0.2A to 0.4A, f_s=400kHz, L=10\mu H

The plots of Figures 9 and 10 highlight the influence of the voltage feedback error amplifier setup and of the input voltage on the load transient response of the TPS55340 boost regulator. In Figure 9 we see the response with 12V input voltage and lower cross-over error amplifier setup. In Figure 10 we see that, although the input voltage is lower, the higher cross-over error amplifier setup improves the load transient response by reducing the overshoot and undershoot surge magnitude.
The plots of Figures 11 and 12 highlight the influence of the voltage feedback error amplifier setup on the line transient response of the TPS55340 boost regulator. In Figure 11 we see the response with lower cross-over error amplifier setup, whereas in Figure 12 we see that the higher cross-over error amplifier setup improves the load transient response by reducing the undershoot surge magnitude.
Experiment 4

The goal of this experiment is to analyze the influence of the input voltage and of the inductor on the maximum average load current that the boost regulator can deliver under current limit conditions. The TPS55340 and the LM5122 boost regulators are used for this experiment.
The goal of this test is to analyze the influence of input voltage, inductor, switching frequency and efficiency on the maximum load current that the boost regulator can deliver under current limit conditions. The test is realized by means of the TPS55340 boost regulator.

The TI-PMLK TPS55340 boost regulator provides an output voltage $V_{out}=24V$, with an input voltage $V_{in}$ from 5V to 12V (1), and a load current $I_{out}$ up to 0.6A. Figure 1 shows the basic circuit schematic, where the devices highlighted are: the input capacitor ($C_I$), the inductor ($L$), the output capacitor ($C_o$), the Schottky diode ($D_1$), the feedback compensation ($R,C,C_s$) and the output voltage sensing ($R_{SH},R_{SL}$). A cycle-by-cycle current-limiting circuit is implemented into the TPS55340 controller, which shuts down the internal MOSFET if its instantaneous current exceeds 6.6A (at 25°C) when it is in the ON state. The current limiting circuit determines the maximum average current $I_{Lmax}$ of the input inductor, whose value depends on input voltage $V_{in}$, switching frequency $f_s$ and inductance $L$. The converter efficiency also influences the current limit as it impacts the average inductor current. Therefore, the maximum output current $I_{outmax}$ the boost regulator can deliver is determined by the operating conditions. The current limiting action inhibits the regulation of output voltage, determining its drop below the desired nominal value.

(1) Restricted range adopted for this educational board, compared to the 2.9V to 32V full range of TPS55340 [5]

[NOTE: The TPS55340 has an internal current sensing, which does not require the use of an additional external current sensing resistor. In the following LM5122 Case Study, we will analyze current limit issues when an external current sensing resistor is used]

**Test**1. We detect the maximum output current that the TPS55340 can deliver to the load, determined by the internal current limit circuit, by slowly increasing the load current while watching the output voltage. When the current load exceeds the current limit threshold, the output voltage regulation is lost. We record the input and output voltages and currents, we calculate the efficiency and we repeat the test for different values of input voltage, inductor, switching frequency and efficiency. The change of efficiency is emulated, for given input voltage, inductor and switching frequency, by means of a resistor mounted in the TPS55340 boost regulator, connected in series to the inductor, which can be bypassed by means of a jumper.

Figure 1. Simplified schematic of the TPS55340 Boost regulator
Cycle-by-cycle current limiting

Figure 2 shows in detail the PWM and current limit circuits. The V\text{clock} signal triggers the MOSFET turn ON at the begin of the switching period. The MOSFET is turned OFF either when the instant sensing signal V\text{s} = R_s \cdot i\text{L} + V\text{ramp} exceeds the feedback control signal V\text{c}, at the input of the PWM comparator, or when the sensing signal V\text{sns} = R_{sns} \cdot i\text{L} exceeds the internal threshold V\text{lim}, at the input of the current limit comparator. Figure 3(a) shows the normal operation. In this case we have:

\[ I_{\text{outmax}} = \frac{I_{\text{out}} + V_{\text{out}} D' D'}{2 (f_s L)} \]

where D' = 1 - D. Figure 3(b) shows the current limit operation. In this case we have:

\[ I_{\text{outmax}} = \frac{D' V_{\text{lim}} - V_{\text{out}} D' D'}{2 (f_s L)} \]

Putting D = 1 - V_{\text{in}}/V_{\text{out}} in (3) yields (4):

\[ I_{\text{outmax}} = \frac{V_{\text{in}}}{V_{\text{out}}} (1 - V_{\text{out}} / V_{\text{in}}) / (2 f_s L) \]

The efficiency η of the converter influences the I_{\text{outmax}} current, as shown in (5):

\[ I_{\text{outmax}} = \frac{V_{\text{in}}}{V_{\text{out}}} (1 - V_{\text{out}} / V_{\text{in}}) / (2 f_s L) \]

Boost converter losses

- MOSFET conduction:
  \[ P_{\text{MOS,C}} = R_{\text{ds}} \cdot I_{\text{out}}^2 \cdot \alpha_{\text{P}} D / D'^2 \]
- MOSFET switching:
  \[ P_{\text{MOS,SW}} = V_{\text{out}} \cdot I_{\text{out}} \cdot t_{\text{sw}} / D' \]
- MOSFET current sensing:
  \[ P_{\text{SNS}} = R_{\text{sNS}} \cdot I_{\text{out}}^2 \cdot \alpha_{\text{PP}} D / D'^2 \]
- Schottky diode conduction:
  \[ P_{\text{RECT}} = V_{\text{F}} \cdot I_{\text{out}} \]
- Inductor winding:
  \[ P_{\text{L,W}} = ESR_{\text{L,W}} \cdot I_{\text{out}}^2 / D'^2 \]
- Inductor core:
  \[ P_{\text{L,C}} = \frac{1}{2} (K_1 \cdot f_s (K_2 \cdot I_{\text{删除成功}})) \]
- Capacitors:
  \[ P_{\text{C IN}} = \frac{1}{2} \cdot ESR_{\text{C IN}} \cdot \Delta i_{\text{PP}}^2 \]
  \[ P_{\text{C OUT}} = \frac{1}{2} \cdot ESR_{\text{C OUT}} \cdot I_{\text{out}}^2 / D' \]
- IC bias:
  \[ P_{\text{IC}} = V_{\text{IN}} \cdot I_{\text{IC}} \]

Good to know

1. \[ D = 1 - \frac{V_{\text{in}}}{V_{\text{out}}} \quad \eta = \frac{P_{\text{out}}}{P_{\text{out}} + P_{\text{loss}}} \]
2. \[ D' = 1 - D \]
3. \[ \alpha_{\text{PP}} = 1 + D^2 \cdot \Delta i_{\text{PP}}^2 / (12 I_{\text{out}}^2) \]
4. \[ \Delta i_{\text{PP}} = V_{\text{in}} / D (f_s L) \]
5. R_{\text{sNS}}, t_{\text{sw}} and Q_s are influenced by the gate driver voltage V_{\text{DR}}, the junction temperature T_j, and the operating conditions;
6. K_1, K_2, x, y coefficients of P_{\text{L,C}} loss formula, depend on inductor core material and size;
7. In case of capacitors in parallel the equivalent ESR has to be calculated;
8. Additional losses depend on PCB traces resistance and ancillary parts;
9. The total converter power losses are:
  \[ P_{\text{loss}} = P_{\text{MOS,C}} + P_{\text{MOS,SW}} + P_{\text{SNS}} + P_{\text{RECT}} + P_{\text{L,W}} + P_{\text{L,C}} + P_{\text{C IN}} + P_{\text{C OUT}} + P_{\text{IC}} \]
TPS55340 Experiment set-up: configuration

The instruments needed for this test are: a DC POWER SUPPLY, four MULTIMETERS and a DC ELECTRONIC LOAD. Figure 4 shows the instruments connections. Follow the instructions provided in next page to set-up the connections.

Figure 4. Experiment set-up.
TPS55340 Experiment set-up: instructions

With all the instruments turned off, make the following connections:

1) connect the POSITIVE (RED) OUTPUT of the DC POWER SUPPLY to the POSITIVE (RED) CURRENT INPUT of the INPUT CURRENT MULTIMETER (ICM)

2) connect the NEGATIVE (BLACK) CURRENT INPUT of the INPUT CURRENT MULTIMETER (ICM) to the INPUT (VIN) of the J₄ screw terminal of the TPS55340 boost regulator

3) connect the NEGATIVE (BLACK) OUTPUT of the DC POWER SUPPLY to the GROUND (GND) of the J₄ screw terminal of the TPS55340 boost regulator

4) connect the OUTPUT (VOUT) of the J₃ screw terminal of the TPS55340 boost regulator to the POSITIVE (RED) CURRENT INPUT of the OUTPUT CURRENT MULTIMETER (OCM)

5) connect the NEGATIVE (BLACK) CURRENT INPUT of the OUTPUT CURRENT MULTIMETER (OCM) to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD

6) connect the NEGATIVE (BLACK) INPUT of the ELECTRONIC LOAD to the GROUND (GND) of the J₃ screw terminal of the TPS55340 boost regulator

7) connect the POSITIVE (RED) VOLTAGE INPUT of the INPUT VOLTAGE MULTIMETER (IVM) to the TEST PIN TP₃ which is the VIN of the TPS55340 boost regulator

8) connect the NEGATIVE (BLACK) VOLTAGE INPUT of the INPUT VOLTAGE MULTIMETER (IVM) to the TEST PIN TP₆ which is GND of the TPS55340 boost regulator

9) connect the POSITIVE (RED) VOLTAGE INPUT of the OUTPUT VOLTAGE MULTIMETER (OVM) to the TEST PIN TP₄ which is VOUT of the TPS55340 boost regulator

10) connect the NEGATIVE (BLACK) VOLTAGE INPUT of the OUTPUT VOLTAGE MULTIMETER (OVM) to the TEST PIN TP₅ which is GND of the TPS55340 boost regulator
**Test#1 (TPS55340): preparation and procedure**

**Initial jumpers set-up (see Figure 5):**
- **J6** shorted left → boost operation enabled
- **J2** shorted → C5 (4.7 µF) output capacitor connected
- **J7** shorted right → switching frequency $f_s = 400$ kHz
- **J17** shorted left → error amplifier gain setup with parts R7, C8, C10 connected (lower cross-over frequency)
- **J1 - J5** shorted → L1 (10 µH) inductor connected
- **J21 - J22** shorted → loss emulation resistor R1 bypassed
- **J8** open → boost operation with internal synchronization

**Test Procedure:**
1) turn on the MULTIMETERS, set the ICM and the OCM in DC CURRENT MODE, set the IVM and the OVM in DC VOLTAGE MODE
2) turn on the POWER SUPPLY (ensure that the OUT ON button is OFF), set the voltage at the initial value of 6V, and set the CURRENT LIMIT > 3A
3) turn on the ELECTRONIC LOAD (ensure that the LOAD ON button is OFF), set the CONSTANT CURRENT MODE and set the current at 0.2A
4) turn ON the POWER SUPPLY “OUT ON” button and adjust the DC POWER SUPPLY knob until you read 6V in the IVM display. In these conditions you should read about 24V in the OVM display, 0A in the OCM display and a very small positive value in the ICM display (if you do read values different than as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
5) turn ON the ELECTRONIC LOAD ON button and adjust the DC POWER SUPPLY knob until you read 6V in the IVM display. In these conditions you should read about 24V in the OVM display, 0.2A in the OCM display, about 0.8A in the ICM display (if the values are much different than the ones listed above, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY and verify the experiment setup)
6) while slowly increasing the load current of the ELECTRONIC LOAD, watch the output voltage value on the OVM display and record the highest value of the load current $I_{\text{out,max}}$ for which you get the output voltage regulated at 24V. When you loose the output voltage regulation, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD, set its current to a value slightly smaller than $I_{\text{out,max}}$, turn ON the “LOAD ON” button of the ELECTRONIC LOAD, and read the input voltage value on the IVM display, the output voltage value on the OVM display, the input current value on the ICM display, the output current value on the OCM display. Repeat this step 6) for all the setup conditions listed in Table 1, by shorting the jumpers J5 - J10 to connect the L2 (3.3 µH) inductor, shorting the jumper J7 to setup the switching frequency $f_s = 600$ kHz, and opening the jumpers J21 - J22 to connect the emulation resistor R1 in series to the inductor [WARNING: you must turn OFF the ELECTRONIC LOAD “LOAD ON” button and the POWER SUPPLY “OUT ON” button while changing the inductor or switching frequency setup]
7) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments.

![Figure 5. TPS55340 boost board: jumpers set-up for Test#1](image)
Test#1 (TPS55340): measure and calculate

For the operating conditions of Table 1:
1) measure the maximum current $I_{\text{outmax}}$ the TPS55340 boost regulator is able to deliver to the load while regulating the output voltage $V_{\text{out}}$ at 24V (detect when output voltage is more than 1% lower than the nominal voltage), and report the value in Table 1
2) measure the average input voltage $V_{\text{in}}$, input current $I_{\text{in}}$, output voltage $V_{\text{out}}$ and output current $I_{\text{out}}$, corresponding to a load current slightly lower than $I_{\text{outmax}}$, and calculate the efficiency of the converter $\eta = (V_{\text{out}} I_{\text{out}}) / (V_{\text{in}} I_{\text{in}})$, and report the result in Table 1.

Table 1. Maximum current delivered by the TPS55340 boost regulator for different input voltage values, inductance, switching frequency and efficiency.

<table>
<thead>
<tr>
<th>$I_{\text{outlim}}$ [A]</th>
<th>$\eta$ [%]</th>
<th>$L = L_1 = 10\mu\text{H}$</th>
<th>$L = L_2 = 3.3\mu\text{H}$</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>$J_{21}\sim J_{22}$ open</td>
<td>$J_{21}\sim J_{22}$ shorted</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$J_{21}\sim J_{22}$ open</td>
<td>$J_{21}\sim J_{22}$ shorted</td>
</tr>
<tr>
<td>$f_s=400\text{kHz}$</td>
<td></td>
<td>$V_{\text{in}}=6\text{V}$</td>
<td>$V_{\text{in}}=12\text{V}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{\text{in}}=6\text{V}$</td>
<td>$V_{\text{in}}=12\text{V}$</td>
</tr>
<tr>
<td>$f_s=600\text{kHz}$</td>
<td></td>
<td>$V_{\text{in}}=6\text{V}$</td>
<td>$V_{\text{in}}=12\text{V}$</td>
</tr>
</tbody>
</table>

Inductors:
- $J_1\sim J_5$ sh: $L=L_1=10\mu\text{H}$, $ESR_{L_1}=62.7m\Omega$
- $J_6\sim J_{10}$ sh: $L=L_2=3.3\mu\text{H}$, $ESR_{L_2}=17.3m\Omega$
- $J_1\sim J_5$ sh or $J_6\sim J_{10}$ sh: $K_1=0.261$, $K_2=0.92$, $x=1.21$, $y=2.01$

TPS55340 integrated MOSFET:
- $R_{\text{ds}}=110m\Omega$
- $I_{\text{DS}}=500\mu\text{A}$
- $\alpha_{\text{sw}}=1.5\text{ns/V}$
- $V_F=325\text{mV}$
- $R_{\text{sns}}=15m\Omega$
- $t_{\text{sw}}=\alpha_{\text{sw}} V_{\text{out}}$

Capacitors:
- $J_2$ sh $ESR_{C_{\text{out}}}=1\text{m}\Omega$
- $ESR_{C_{\text{in}}}=1.5\text{m}\Omega$

Answer:

1. Is the load current limit higher with inductor $L_1$ or with inductor $L_2$? [ ] higher with $L_1$ [ ] higher with $L_2$ [ ] it depends on line voltage [ ] no influence

2. Does a higher converter efficiency increase or decrease the load current limit? [ ] increases [ ] decreases [ ] it depends on line voltage [ ] it depends on inductor

3. Does a higher input voltage increase or decrease the load current limit? [ ] increases [ ] decreases [ ] no influence [ ] it depends on inductor
The goal of this test is to analyze the influence of parasitic inductances on the maximum load current that the boost regulator can deliver under current limit. The test is realized by means of the LM5122 boost regulator.

The TI-PMLK LM5122 boost regulator operates with \( V_{\text{in}} = \{9, 20\} \text{V} \)\(^{(1)}\), while regulating the output voltage at the nominal value \( V_{\text{out}} = 24 \text{V} \), \( I_{\text{out}} = \{0, 2\} \text{A} \). Figure 6 shows the simplified circuit schematic of the regulator. The LM5122 features a peak cycle-by-cycle current limit function. If the current sensing voltage between the pins CSP and CSN exceeds the 75mV cycle-by-cycle current limit threshold, the current limit comparator immediately terminates the LO output. As highlighted in the TPS55340 Case Study, the current limiting circuit determines the maximum average current \( I_{\text{max}} \) of the input inductor, whose value depends on the input voltage \( V_{\text{in}} \), on the switching frequency \( f_s \) and on the inductance \( L \). Unlike the TPS55340, the LM5122 uses the external resistor \( R_s \) to sense the inductor current. The surface-mount current sensing resistors normally used for peak-current controllers are characterized by a very small parasitic inductance. The TI-PMLK LM5122 boost regulator mounts a through-hole U-shape shunt resistor, which is used to hang a current probe for oscilloscope acquisition of the inductor current waveform, and which is also used as current sensing resistor for the peak current control. The parasitic inductance of such sensing resistor is in the range of tens of nH and it influences the current limit.

\(^{(1)}\) Restricted range adopted for this educational board, compared to the 4.5V to 65V full range of LM5122 [4]

**Test#1.** We detect the maximum output current that the LM5122 can deliver to the load, set by the internal current limit circuit, by slowly increasing the load current while watching the output voltage. When the current threshold is reached, the output voltage regulation is lost. We observe the effect of the parasitic inductance of the sensing resistor on the maximum output current, while operating the boost converter with the two power inductors of values 3.3\( \mu \text{H} \) and 10\( \mu \text{H} \) mounted on the board. We will also see that the maximum current that the LM5122 boost regulator can deliver can be increased, when the 3.3\( \mu \text{H} \) inductor is used, by modifying the sensing resistor.
Figure 7 shows the schematic of the LM5122 boost regulator with peak-current-control and current limit circuitry. The current sensing resistor is highlighted. It is characterized by a resistance $R_{\text{sns}}$ and a parasitic inductance $L_{\text{sns}}$. To assess the impact of $L_{\text{sns}}$ on the overall operation of the peak-current controlled boost converter, let us first analyze the operation with $L_{\text{sns}}=0$. Like in TPS55340 boost regulator, the $V_{\text{clk}}$ signal triggers the MOSFET $Q_L$ turn ON at the begin of the switching period. The MOSFET $Q_L$ is turned OFF either when the instant sensing signal $V_s=R_{\text{sns}}i_L+V_{\text{ramp}}$ exceeds the feedback control signal $V_c$, at the input of the PWM comparator, or when the sensing signal $V_{\text{sns}}=R_{\text{sns}}i_L$ exceeds the internal threshold $V_{\text{lim}}$, at the input of the current limit comparator. Therefore, if the load current does not exceed the limit $I_{\text{outmax}}=\frac{hV_{\text{in}}[(I_{\text{lim}}-V_{\text{in}})(1-V_{\text{in}}/V_{\text{out}})/(2f_{\text{s}}L)]-V_{\text{in}}L_{\text{sns}}}{V_{\text{out}}}$, the waveforms of $V_s$, $V_c$, $V_{\text{sns}}$, and $V_{\text{ramp}}$ will look as shown in Figure 8(a). The inductance $L_{\text{sns}}$ influences the maximum inductor current that the boost converter can sustain before the current limit shuts down the MOSFET $Q_L$. $L_{\text{sns}}$ is in series with the inductance $L$, which is much bigger than $L_{\text{sns}}$. Thus, the slope of the inductor current is determined by its own inductance $L$.

\[ I_{\text{outmax}} = \eta \frac{V_{\text{in}}[(I_{\text{lim}}-V_{\text{in}})(1-V_{\text{in}}/V_{\text{out}})/(2f_{\text{s}}L)]-V_{\text{in}}L_{\text{sns}}}{V_{\text{out}}} \]

The formula (6) highlights that a smaller inductance $L$ increases the effect of the parasitic inductance $L_{\text{sns}}$ on the maximum current that can be delivered by the boost converter.

Figure 8.

(a) $V_{\text{sns}}$, $V_c$, $V_s$, $V_{\text{sns}}$ @ $L_{\text{sns}}=0$.
(b) $V_{\text{sns}}$, $V_c$, $V_s$, $V_{\text{sns}}$ @ $L_{\text{sns}}=0$.
(c) $V_{\text{sns}}$, $V_c$, $V_s$, $V_{\text{sns}}$ @ $L_{\text{sns}}=0$.

The slope is $V_i/L>0$ since the MOSFET $Q_L$ turns ON, at the begin of the switching period, until the MOSFET $Q_L$ turns OFF, at the instant where $V_s=V_c$, then the slope is $(V_s-V_{\text{ramp}})/L<0$ until the begin of the next switching period. As a consequence, the voltage across the parasitic inductance $L_{\text{sns}}$ is $V_{\text{sns}}=V_{\text{in}}L_{\text{sns}}/L>0$ during the ON time of the MOSFET $Q_L$. In this interval of time, the signal $V_s$ is used by the peak current control PWM comparator and the signal $V_{\text{sns}}$ is used by the current limit comparator to determine the boost converter duty-cycle. Figures 8(b) and 8(c) highlight that the effect of the $V_{\text{sns}}$ voltage across the parasitic inductance is a rise in the $V_s$ and $V_c$ signals. If $L_{\text{sns}}$ is not too big, the $V_{\text{sns}}$ signal does not exceed the $V_{\text{lim}}$ limit, as shown in Figure 8(b). Then, the $V_s$ signal reaches the control signal level $V_c$ before the $V_{\text{sns}}$ reaches the $V_{\text{lim}}$ limit. Then, the action of the peak-current-control PWM modulator is prevalent, and it is able to set the required duty-cycle to regulate the output voltage. If $L_{\text{sns}}$ is too big, the $V_{\text{sns}}$ reaches the $V_{\text{lim}}$ limit before the $V_s$ signal reaches the control signal level $V_c$, as shown in Figure 8(c). Then, the action of the current limit comparator is prevalent, and the peak-current-control PWM modulator it not able to set the required duty-cycle to regulate the output voltage. The maximum inductor current is thus reduced by the parasitic inductance and it is given by (6):

\[ I_{\text{outmax}} = \eta \frac{V_{\text{in}}[(I_{\text{lim}}-V_{\text{in}})(1-V_{\text{in}}/V_{\text{out}})/(2f_{\text{s}}L)]-V_{\text{in}}L_{\text{sns}}}{V_{\text{out}}} \]
The instruments needed for this test are: a DC POWER SUPPLY, four MULTIMETERS, an OSCILLOSCOPE and a DC ELECTRONIC LOAD. Figure 9 shows the instruments connections. Follow the instructions provided in next page to set-up the connections.

Figure 9. Experiment set-up.
With all the instruments turned off, make the following connections:

1) connect the POSITIVE (RED) OUTPUT of the DC POWER SUPPLY to the POSITIVE (RED) CURRENT INPUT of the INPUT CURRENT MULTIMETER (ICM)

2) connect the NEGATIVE (BLACK) CURRENT INPUT of the INPUT CURRENT MULTIMETER (ICM) to the INPUT (VIN) of the J₁₁ screw terminal of the LM5122 boost regulator

3) connect the NEGATIVE (BLACK) OUTPUT of the DC POWER SUPPLY to the GROUND (GND) of the J₁₁ screw terminal of the LM5122 boost regulator

4) connect the OUTPUT (VOUT) of the J₁₂ screw terminal of the LM5122 boost regulator to the POSITIVE (RED) CURRENT INPUT of the OUTPUT CURRENT MULTIMETER (OCM)

5) connect the NEGATIVE (BLACK) CURRENT INPUT of the OUTPUT CURRENT MULTIMETER (OCM) to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD.

6) connect the NEGATIVE (BLACK) INPUT of the ELECTRONIC LOAD to the GROUND (GND) of the J₁₂ screw terminal of the LM5122 boost regulator

7) connect the POSITIVE (RED) VOLTAGE INPUT of the INPUT VOLTAGE MULTIMETER (IVM) to the TEST PIN TP₁₁ which is the VIN of the LM5122 boost regulator

8) connect the NEGATIVE (BLACK) VOLTAGE INPUT of the INPUT VOLTAGE MULTIMETER (IVM) to the TEST PIN TP₁₃ which is GND of the LM5122 boost regulator

9) connect the POSITIVE (RED) VOLTAGE INPUT of the OUTPUT VOLTAGE MULTIMETER (OVM) to the TEST PIN TP₁₂ which is VOUT of the LM5122 boost regulator

10) connect the NEGATIVE (BLACK) VOLTAGE INPUT of the OUTPUT VOLTAGE MULTIMETER (OVM) to the TEST PIN TP₁₄ which is GND of the LM5122 boost regulator
Test#2 (LM5122): preparation and procedure

Initial jumpers set-up (see Figure 10):
- J13 open → no external synchronization signal connected
- J14 open → low slope current mode compensation
- J15 open → switching frequency $f_s = 250\text{kHz}$
- J16 shorted left → SOM setup
- J18 open, J19 shorted, J20 open → error amplifier gain setup with parts $R_{24}$, $C_{29}$, $C_{34}$ connected (high cross-over frequency with $L = L_3 = 10\mu\text{H}$, and high slope compensation ramp)
- J23-J24 shorted → $L_3 (10\mu\text{H})$ inductor connected

Test Procedure:
1) turn on the MULTIMETERS, set the ICM and the OCM in DC CURRENT MODE, set the IVM and the OVM in DC VOLTAGE MODE
2) turn on the POWER SUPPLY (ensure that the OUT ON button is OFF), set the voltage at the initial value of 10V and set the CURRENT LIMIT > 3A
3) turn on the ELECTRONIC LOAD (ensure that the LOAD ON button is OFF), set the CONSTANT CURRENT MODE and set the current at 0.2A
4) turn ON the POWER SUPPLY “OUT ON” button and adjust the DC POWER SUPPLY knob until you read 6V in the IVM display. In these conditions you should read about 24V in the OVM display, 0A in the OCM display and a very small positive value in the ICM display (if you do read values different than as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
5) turn ON the ELECTRONIC LOAD ON button and adjust the DC POWER SUPPLY knob until you read 6V in the IVM display. In these conditions you should read about 24V in the OVM display, 0.2A in the OCM display, about 0.8A in the ICM display (if the values are much different than the ones listed above, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY and verify the experiment setup)
6) while slowly increasing the load current of the ELECTRONIC LOAD, watch the output voltage value on the OVM display and record the highest value of the load current $I_{\text{out,max}}$ for which you get the output voltage regulated at 24V. When you lose the output voltage regulation, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD, set its current to a value slightly smaller than $I_{\text{out,max}}$, turn ON the “LOAD ON” button of the ELECTRONIC LOAD, and read the input voltage value on the IVM display, the output voltage value on the OVM display, the input current value on the ICM display, the output current value on the OCM display. Repeat this step 6) for all the setup conditions listed in Table 2, by shorting the jumpers $J_{23}$ - $J_{24}$ to connect the $L_4 (3.3\mu\text{H})$ inductor, shorting the jumper $J_{15}$ to setup the switching frequency $f_s = 500\text{kHz}$ and opening the jumper $J_{16}$ to setup DEM operation [WARNING: you must turn OFF the ELECTRONIC LOAD “LOAD ON” button and the POWER SUPPLY “OUT ON” button while changing the inductor or switching frequency setup]
7) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments.

Figure 10. LM5122 board: jumpers set-up for Test#2
Test#2 (LM5122): measure and calculate

For the operating conditions of Table 2:
1) measure the maximum current \( I_{\text{out max}} \) the LM5122 boost regulator is able to deliver to the load while regulating the output voltage \( V_{\text{out}} \) at 24V regulation of the (detect when output voltage is more than 1% lower than the nominal voltage), and report the value in Table 2
2) measure the average input voltage \( V_{\text{in}} \), input current \( I_{\text{in}} \), output voltage \( V_{\text{out}} \) and output current \( I_{\text{out}} \) corresponding to a load current slightly lower than \( I_{\text{out max}} \), and calculate the efficiency of the converter \( \eta = (V_{\text{out}} I_{\text{out}})/(V_{\text{in}} I_{\text{in}}) \), and report the result in Table 2

Table 2: Maximum current delivered by the LM5122 boost regulator for different input voltage values, inductance, switching frequency and mode of operation

<table>
<thead>
<tr>
<th>( I_{\text{out max}} ) [A]</th>
<th>( \eta ) [%]</th>
<th>( L = L_3 = 10\mu\text{H} )</th>
<th>( L = L_4 = 3.3\mu\text{H} )</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>SOM setup</td>
<td>DEM setup</td>
<td>SOM setup</td>
</tr>
<tr>
<td>( f_s = 250\text{kHz} )</td>
<td>( V_{\text{in}} = 10\text{V} )</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>( V_{\text{in}} = 20\text{V} )</td>
<td></td>
<td></td>
</tr>
<tr>
<td>( f_s = 500\text{kHz} )</td>
<td>( V_{\text{in}} = 10\text{V} )</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>( V_{\text{in}} = 20\text{V} )</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Inductor:
\( J_{23} - J_{24} \) shorted \( \rightarrow \) inductor \( L_3 \) (powdered core, 10\,\mu\text{H}, 2.6A, 0.057\,\Omega) connected
\( J_{24} - J_{25} \) shorted \( \rightarrow \) inductor \( L_4 \) (powdered core, 3.3\,\mu\text{H}, 10A, 0.0195\,\Omega) connected

Switching frequency:
\( J_{15} \) open \( \rightarrow f_s = 250\text{kHz} \)
\( J_{15} \) shorted \( \rightarrow f_s = 500\text{kHz} \)

Operation mode:
\( J_{15} \) open \( \rightarrow \) Diode Emulation Mode (DEM)
\( J_{15} \) shorted left \( \rightarrow \) Synchronous Operation Mode (SOM)

Answer:
1. Is the load current limit higher with inductor \( L_3 \) or with inductor \( L_4 \)?
   - higher with \( L_3 \)
   - higher with \( L_4 \)
   - it depends on line voltage
   - no influence

2. Is the load current limit higher with DEM setup or with SOM setup?
   - DEM
   - SOM
   - it depends on line voltage
   - it depends on inductor

3. Does a higher input voltage increase or decrease the load current limit?
   - increases
   - decreases
   - no influence
   - it depends on inductor
In Test#1 we are interested in investigating how the input voltage, the switching frequency, the inductance and the efficiency influence the current limit of the TPS55340 boost regulator. The current limit threshold of a boost regulator is determined by the inductor peak current value. Operating conditions involving a higher inductor peak current value result in a lower current limit threshold. The inductor peak current value is the sum of the average inductor current and half the peak-to-peak ripple. A higher input voltage $V_{in}$ involves a lower average inductor current. Therefore, the operation at a higher input voltage contributes to increase the current limit threshold. If $V_{in} < V_{out}/2$, the ripple current increases as $V_{in}$ increases. In this case, the current limit threshold may increase or decrease, as the input voltage increases, depending on the balance between its opposed effects on average and ripple current. If $V_{in} > V_{out}/2$ the ripple decreases as $V_{in}$ increases. In this case, the current limit threshold increases as the input voltage increases. For the range of input voltage specified in Test#1, we are satisfying the condition $V_{in} < V_{out}/2$. The inductor peak-to-peak ripple current increases if the switching frequency $f_s$ decreases or if the inductance $L$ decreases. A lower efficiency determines a decrease of the load current limit, as it involves higher losses and then a higher average inductor current. The values of $f_s$ and $L$ and $V_{in}$ specified in Test#1 result in a load current limit at 12V higher than at 6V.

In Test#2 we are interested in investigating how the input voltage, the switching frequency, the inductance and the parasitic inductance of the current sensing resistor influence the current limit of the LM5122 boost regulator.

The discussion about the impact of the input voltage $V_{in}$, the switching frequency $f_s$ and the inductance $L$ on the load current limit relevant to TPS55340 boost regulator apply to LM5122 boost regulator as well. However, you may have observed that the load current limit threshold can get very low (down to $\approx 15mA$) when the inductor $L_4$ (3.3 $\mu$H) is used, compared to the much higher load current limit threshold achieved when the inductor $L_3$ (10 $\mu$H) is used (above 1.5A). This is the effect of the parasitic inductance $L_{sns}$ of the current sensing resistor $R_{11}$. Indeed, as highlighted in the formula (6) provided in the LM5122 current limit Theory Background section, a smaller inductance $L$ amplifies the voltage drop $V_{L_{sns}}$ across the parasitic inductance $L_{sns}$. With $L=3.3\mu$H we have a voltage drop $V_{L_{sns}}$ three times greater than with $L=10\mu$H. With $L=10\mu$H, the voltage drop $V_{L_{sns}}$ across the parasitic inductance $L_{sns}$ is not sufficiently large to cause the action of the current limit, and the load current can be high (see Figure 3(b) of LM5122 current limit Theory Background section). With $L = 3.3\mu$H, the voltage drop $V_{L_{sns}}$ gets large and the current limit is reached even with a small load current (see Figure 3(c) of LM5122 current limit Theory Background section).

[NOTE: If you want to increase the LM5122 boost regulator current limit threshold, it is sufficient that you solder a U-shape current shunt in parallel to the one mounted in the LM5122 board, as shown in Figure 11. If the additional shunt is identical to the one in the board, you reduce the parasitic inductance $L_{sns}$ to one half and you can measure one half of the inductor current through each of them. As an alternative, you can solder a 2cm long wire, with 1mm to 2mm diameter, between the terminals of the U-shape current shunt mounted in the LM5122 board]
The plots of Figures 12 to 15 show the results of experimental measurements performed on the TPS55340 boost regulator while detecting the load current limit.

The plots of Figures 12 and 13 compare the load current limit conditions detected with 5V input voltage and 12V input voltage for fixed values of the switching frequency $f_s$ and of the inductance $L$. In the operating conditions of Figure 12, the average inductor current is about 3.3A (the zero reference of the green trace is out of the scope range) while the peak to peak ripple is about 1A, resulting in 0.67A load current limit. In the operating conditions of Figure 13, instead, the average inductor current is about 1.35A while the peak to peak ripple is about 1.5A, resulting in 1.5A load current limit.
Experimental plots

The plots of Figures 14 and 15 compare the load current limit conditions detected with 12V input voltage and 18V input voltage for fixed values of the switching frequency $f_s$ and two values of the inductance $L$. In the operating conditions of Figure 14, the average inductor current is about 1.35A (the zero reference of the green trace is out of the scope range) while the peak to peak ripple is about 0.5A, resulting in 1.10A load current limit. In the operating conditions of Figure 15, instead, the average inductor current is about 0.90A while the peak to peak ripple is about 1.25A, resulting in 1.65A load current limit.

[NOTES: 1) The load current limit is influenced by the temperature. The TPS55340 datasheet [5] provides the curve of inductor current limit vs temperature from which you can derive the load current limit based on formula (5) of the TPS55340 current limit Theory Background section. 2) The Theory Background section of Experiment 3 highlights that the load current influences the voltage loop gain of the TPS55340 boost regulator. As a side exercise, given the input voltage $V_{in}$, the switching frequency $f_s$, the inductance $L$, and the error amplifier compensation, verify if there is a load current threshold value beyond which the TPS55340 becomes unstable]
Experiment 5

The goal of this experiment is to analyze how the operating conditions, the peak current control slope compensation and the voltage feedback compensation influence the line transient response of the boost converter. The LM5122 boost regulator is used in this experiment.
The goal of this experiment is to analyze how the load current, the current slope compensation setup and the voltage feedback compensation setup influence the line transient response of the boost converter.

The TI-PMLK LM5122 boost regulator operates with $V_{in}=[9,20]V$\(^{[1]}\), while regulating the output voltage at the nominal value $V_{out}=24V$, $I_{out}=[0,2]A$. Figure 1 shows the basic circuit schematic. The power devices highlighted in the figure are: the input capacitor ($C_{in}$), the inductor ($L$), the output capacitor ($C_{out}$), the MOSFETs ($Q_1, Q_2$), the feedback compensation ($R_{fb1}, R_{fb2}, C_{f1}, R_{f2}, C_{f2}$), the current slope compensation resistor ($R_{slope}$) and the inductor current sensing resistor ($R_s$). A regulator has a good line transient response if the magnitude of the output voltage surges caused by the input voltage changes is small. The LM5122 boost regulator implements the Peak-Current Mode Control (PCMC), which provides good line voltage noise rejection, as it is characterized by an inherent feedforward feature. The Power Supply Rejection Ratio (PSRR) is a measure of the line noise rejection capability of a voltage regulator in the frequency domain. The PSRR is defined as the ratio between the output voltage perturbation $\Delta V_{out}$ and the input voltage perturbation $\Delta V_{in}$ as a function of the frequency $f$ of the input voltage perturbation, $PSRR(f)=\frac{\Delta V_{out}(f)}{\Delta V_{in}(f)}$. The PSRR depends on the current-mode control setup, on the passive power components, on line/load operating conditions and on the voltage feedback error amplifier gain. If the PSRR is small, the line transient response is better.

\(^{[1]}\) Restricted range adopted for this educational board, compared to the 4.5V to 65V full range of LM5122 [4]

Test#1. We measure the magnitude of the output voltage surges caused by a change in the input voltage, at different load current conditions and with a different setup of the slope compensation of the current control loop. The voltage feedback compensation is changed to keep the crossover frequency high with the different slope compensation setup. The PSRR is calculated and its value is correlated with the output voltage surge magnitude. The goal is to analyze the impact of operating conditions and slope compensation on line transient response and correlate this with the PSRR formulae from the Theory Background.

Test#2. We measure the magnitude of the output voltage surges caused by a change in the input voltage, at different load current conditions and with a different setup of the voltage feedback compensation, providing different crossover with a given slope compensation setup. The PSRR is calculated and its value is correlated with the output voltage surge magnitude. The goal is to analyze the impact of operating conditions and feedback compensation on line transient response and correlate this with the PSRR formulae from the Theory Background.
The fundamentals of line transient response of peak-current controlled boost converter in CCM and its correlation with the PSRR are summarized below. (see [1][2][3][6] for more details on boost topology operation, dynamic modeling and current-mode control analysis and design; see [4] for more details on LM5122 operation and features)

Figure 2(b) shows the Peak Current Control (PCC) circuitry, while Figure 2(a) shows the PCC feedforward action, determining a rapid duty-cycle change when the input voltage changes.

The theory proves [6] that the PWM modulator law is given by (1):

\[ \dot{d} = F_m \left[ \dot{V}_c - A \dot{i}_L - F \dot{V}_{out} \right] \]

where the "\(\Delta\)" means the variable is the perturbation with respect to steady-state, and:

\[ F_m = \frac{f_1}{s + s_c(1 - \frac{1}{M})}; \quad A_s = R_{es} A_{es}; \quad s_c = \frac{K}{L}; \quad s = \frac{A V_m}{s_c}; \quad F = \frac{s D}{2 f_c V_m}; \quad M = \frac{V_m}{V_m} \]

From (1), the simplified Control-to-Output (Cto) gain \( G_{to} \) of PCMC boost can be obtained:

\[ G_{to}(s) = \frac{V_m}{s} \left( 1 + \frac{s}{ω_{es}} \right) \left( 1 + \frac{s}{ω_{wv}} \right)^{-1} \left( 1 + \frac{s}{ω_{s}} \right) \left( 1 + \frac{s}{ω_{w}} \right)^{-1} \left( 1 + \frac{s}{ω_{D}} \right) \]

where:

\[ ω_{es} = \frac{1}{ESR_{out} C_{out}}; \quad ω_{wv} = \frac{V_m^2}{V_{out} L}; \quad ω_{w} = \frac{2V_m}{s_c V_{out}} \quad Q_s = \frac{1}{\pi} \left[ \frac{V_m}{V_{out}} (1 + \frac{s}{s_c}) - \frac{1}{2} \right] \]

For LM5122 it is \( K_s = 6 \times 10^9 \)

The gain of a Type II Error Amplifier (EA) (assuming ideal OP-AMP) is given by (5):

\[ G_{EA}(s) = \frac{V_m}{s} \left( 1 + \frac{A F_m L M^2}{s V_m V_{out} A_s} \right) \]

Merging the boost converter open-loop dynamic model [1] with the Cto gain of the peak-current controlled boost given by (3) and the Type II EA \( G_{EA}(s) \) gain given by (5) provides the explicit expression of the closed loop PSRR(s) = \( \frac{\dot{v}_{out}}{\dot{v}_{in}} \) gain. The simplified form of the closed-loop PSRR at Low Frequency (LF) and High Frequency (HF) are given by (6):

\[ PSRR_{LF} = \frac{V_m}{s} \left( 1 + \frac{A F_m L M^2}{s V_m V_{out} A_s} \right) \]

The formulae (6) show that:
- higher \( ω_e \) means better PSRR_{LF};
- smaller \( ω_e \) means better PSRR_{HF};
- the Error Amplifier influences the PSRR_{LF} only;
- the ESR of the output capacitor influences the PSRR_{HF} only;
- the slope compensation resistor \( R_s \) and the line/load conditions influence the PSRR globally.

Figure 3 shows the influence of \( R_s \) on PSRR and line step response.

- The frequencies \( ω_e, ω_p, ω_s \) of Type II error amplifier are determined from the desired closed loop cross-over frequency \( ω_e \) and phase margin \( ϕ \): \( ω_e = \omega_p / |G_{EA}(ω_p)|K \), \( ω_p = ω_e / K \), \( ω_s = ω_e K \), where \( K = \tan(\frac{ϕ}{2}) \) and \( ω_p = ω_e / 90° - 2G_{EA}(ω_e) \) [1][2][3].
- The limited dc gain of a real OP-AMP makes the real PSRR_{LF} flat.
- The sampling effect and the limited bandwidth of the OP-AMP influence the real PSRR_{HF}.
- The input capacitor and the line impedance influence the PSRR.

Good to know:

- The frequencies \( ω_e, ω_p, ω_s \) of Type II error amplifier are determined from the desired closed loop cross-over frequency \( ω_e \) and phase margin \( ϕ \): \( ω_e = \omega_p / |G_{EA}(ω_p)|K \), \( ω_p = ω_e / K \), \( ω_s = ω_e K \), where \( K = \tan(\frac{ϕ}{2}) \) and \( ω_p = ω_e / 90° - 2G_{EA}(ω_e) \) [1][2][3].
- The limited dc gain of a real OP-AMP makes the real PSRR_{LF} flat.
- The sampling effect and the limited bandwidth of the OP-AMP influence the real PSRR_{HF}.
- The input capacitor and the line impedance influence the PSRR.
The instruments needed for this experiment are: a POWER SUPPLY with DC and DYNAMIC MODE options, a DC ELECTRONIC LOAD and an OSCILLOSCOPE. Figure 4 shows the instruments connections. Follow the instructions provided in next page to set-up the connections.

WARNING!
Keep the wires 1) and 2) as short as possible to limit the parasitic inductance.
Experiment set-up: instructions

With all the instruments turned off, make the following connections:

1) connect the POSITIVE (RED) OUTPUT of the DC POWER SUPPLY to the INPUT (VIN) of the J11 screw terminal of the LM5122 boost regulator

2) connect the NEGATIVE (BLACK) OUTPUT of the DC POWER SUPPLY to the GROUND (GND) of the J11 screw terminal of the LM5122 boost regulator

3) connect the OUTPUT (VOUT) of the J12 screw terminal of the LM5122 boost regulator to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD

4) connect the GROUND (GND) of the J12 screw terminal of the LM5122 boost regulator to the NEGATIVE (BLACK) INPUT of the ELECTRONIC LOAD

5) connect a current probe to channel 1 of the OSCILLOSCOPE and hang it on the sensing resistor $R_{11}$ of the LM5122 boost regulator, ensuring that the arrow printed on the probe clamps corresponds to the current that enters the inductor (the arrow must point upside when looking the LM5122 boost board frontally, as shown in Figure 5)

6) connect a voltage probe to channel 2 of the OSCILLOSCOPE, hang its positive tip to TEST PIN $TP_{12}$ which is the output voltage of the LM5122 boost regulator. This probe will be used to measure the DC+AC components of the output voltage. **WARNING: DO NOT INVERT** the positive and ground connections of the voltage probe

7) connect a voltage probe to channel 3 of the OSCILLOSCOPE, hang its positive tip to TEST PIN $TP_{12}$ which is the output voltage of the LM5122 boost regulator. This probe will be used to measure the AC component of the output voltage. **WARNING: DO NOT INVERT** the positive and ground connections of the voltage probe

8) connect a voltage probe to channel 4 of the OSCILLOSCOPE, hang its positive tip to TEST PIN $TP_{11}$ which is the input voltage of the LM5122 boost regulator. **WARNING: DO NOT INVERT** the positive and ground connections of the voltage probe
Test#1: preparation and procedure

Initial jumpers set-up (see Figure 5):

- **J13** open → no external synchronization signal connected
- **J14** shorted → \( R_{sl}=10\,\text{k}\Omega \) (high slope current mode compensation)
- **J15** shorted → switching frequency \( f_s = 500\,\text{kHz} \)
- **J16** shorted left → SOM setup
- **J18** shorted, **J19** open, **J20** open → error amplifier gain setup with parts \( R_{23}, C_{28}, C_{33} \) connected (high cross-over frequency with \( L=L_3=10\,\mu \text{H}, \) and high slope compensation ramp)
- **J23 - J24** shorted → \( L_3=10\,\mu \text{H} \) inductor connected

---

Test Procedure:

1) turn on the OSCILLOSCOPE, set CH-1 in DC 50\,\Omega coupling mode, set CH-3 and CH-4 in DC 1\,\text{M}\Omega coupling mode, set CH-2 in AC 1\,\text{M}\Omega coupling mode, and execute the “de-gauss” of the current probe to remove possible dc bias in the current probe.

2) turn on the POWER SUPPLY (ensure that the “OUT ON” button is OFF), set the DYNAMIC MODE, with a 250\,\text{Hz}, 50\% duty-cycle square-wave voltage between 18V and 20V (you can adjust these values based on the features of the POWER SUPPLY, ensuring that the input voltage is limited within the 18V to 20V range) and set the CURRENT LIMIT at 4.5\,\text{A}.

3) turn on the ELECTRONIC LOAD (ensure that the “LOAD ON” button is OFF), set the DC CURRENT at 0.5\,\text{A}.

4) turn ON the POWER SUPPLY “OUT ON” button and the “LOAD ON” button of the ELECTRONIC LOAD. In these conditions you should see the DC+AC output voltage waveform on the CH-2 trace as a flat line around 24\,\text{V} level with small periodical surges, the AC component of the output voltage waveform on CH-3 trace as a flat line around 0\,\text{V} level with small periodical surges, the input voltage waveform on CH-4 trace as a square-wave between 18V and 20V, and the inductor current waveform on the CH-1 trace as a square-wave between about 0.6\,\text{A} and 2.5\,\text{A} (if the waveforms you see are much different than as described above, turn OFF the the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY and verify previous steps).

5) read the magnitude of the output voltage surges with cursor or measurement functions of the OSCILLOSCOPE, record the values in Table 1 and repeat this step for all the load current values listed in Table 1 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button and the ELECTRONIC LOAD “LOAD ON” button while changing the load current).

6) turn OFF the the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, open the jumper **J14** to set the slope compensation resistance at \( R_{sl}=100\,\text{k}\Omega \), open the jumper **J18** and short the jumper **J19** to set the voltage error amplifier at high crossover with small slope compensation, and repeat the steps 4) and 5)

7) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments.

---

Figure 5. LM5122 board: jumpers set-up for Test#1
Test#1: measure and calculate

For the operating conditions of Table 1:

1) measure the peak output voltage overshoot and undershoot with a dynamic voltage source connected to the input, imposing a 18V to 20V square-wave, and an adjustable DC load connected to the output

2) calculate the coefficients \( \omega_{LF} \) and \( \omega_{HF} \) of the PSRR formulae (6) provided in the Theory Background section

3) compare the magnitude of the output voltage line transient overshoot/undershoot with the magnitude of the coefficients \( \omega_{LF} \) and \( \omega_{HF} \) \[NOTE: a higher \( \omega_{LF} \) and a lower \( \omega_{HF} \) improve the PSRR_{LF} and the PSRR_{HF}, respectively, and a better PSRR is expected to correspond to a smaller magnitude of line transient output voltage surges\]

Table 1. Line transient response of LM5122 boost regulator with \( f_s = 500\text{kHz} \), \( L = 10\mu\text{H} \), SOM setup, and different slope compensation and load current setup

<table>
<thead>
<tr>
<th>( \Delta V_{out} ) [mV]</th>
<th>( \omega_{LF} ) [rad/s]</th>
<th>( \omega_{HF} ) [rad/s]</th>
<th>(a) high crossover (( J_{18} ) sh, ( J_{19} ) op, ( J_{20} ) op) with high slope (( J_{14} ) sh)</th>
<th>(b) high crossover (( J_{14} ) op, ( J_{19} ) sh, ( J_{20} ) op) with low slope (( J_{14} ) op)</th>
</tr>
</thead>
<tbody>
<tr>
<td>( V_{in} : 18V \rightarrow 20V )</td>
<td>( V_{in} : 20V \rightarrow 18V )</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1) I_{out}=0.5A</td>
<td>2) I_{out}=1.0A</td>
<td>3) I_{out}=1.5A</td>
<td>2) I_{out}=0.5A</td>
<td>3) I_{out}=1.5A</td>
</tr>
<tr>
<td>1)</td>
<td>2)</td>
<td>3)</td>
<td>1)</td>
<td>2)</td>
</tr>
</tbody>
</table>

\( (*) \) the extreme values 18V and 20V can be changed according to available power supply limitations. It is recommended to not exceed 2V peak-to-peak amplitude and to keep the minimum input voltage above 15V.

Feedback compensation components:

- \( J_{18} \) sh, \( J_{19} \) op, \( J_{20} \) op: \( R_c=R_{23}=169\Omega \), \( C_c=C_{28}=1nF \), \( C_h=C_{33}=27pF \); [high \( \omega_c \) with \( L=10\mu\text{H}, R_s=10k\Omega \)]
- \( J_{18} \) op, \( J_{19} \) sh, \( J_{20} \) op: \( R_c=R_{24}=178\Omega \), \( C_c=C_{29}=330pF \), \( C_h=C_{34}=82pF \); [high \( \omega_c \) with \( L=10\mu\text{H}, R_s=100k\Omega \)]
- \( J_{18} \) op, \( J_{19} \) op, \( J_{20} \) sh: \( R_c=R_{25}=24.3k\Omega \), \( C_c=C_{30}=22nF \), \( C_h=C_{35}=4.7nF \); [low \( \omega_c \) with \( L=10\mu\text{H}, R_s=100k\Omega \)]

Switching frequency:

- \( J_{15} \) open \( \rightarrow f_s = 250kHz\)  
- \( J_{15} \) shorted \( \rightarrow f_s = 500kHz\)  

Current control slope compensation:

- \( J_{14} \) open \( \rightarrow R_s=100.9k\Omega \) [low slope]  
- \( J_{14} \) shorted \( \rightarrow R_s=10k\Omega \) [high slope]

Answer:

1. Does the magnitude of output voltage transient surges increase or decrease when the slope compensation increases?
   - No
   - Decreases
   - Increases
   - It depends on: ___________

2. Is the magnitude of the coefficients \( \omega_{LF} \) and \( \omega_{HF} \) consistent with the magnitude of the output voltage surges?
   - No
   - Yes
   - It depends on: ___________

3. Are output voltage transient surges bigger for low load current or for high load current?
   - Yes
   - No
   - It depends on: ___________
Test#2: preparation and procedure

Experiment 5

Initial jumpers set-up (see Figure 6):
- J13 open → no external synchronization signal connected
- J14 open → Rsl=100kΩ (low slope current mode compensation)
- J15 shorted → switching frequency fs = 500kHz
- J16 shorted left → SOM setup
- J18 open, J19 open, J20 shorted → error amplifier gain setup with parts R25, C30, C35 connected (low cross-over frequency with L3 =10µH, and small slope compensation ramp)
- J23 - J24 shorted → L3 (10µH) inductor connected

Test Procedure:

1) turn on the OSCILLOSCOPE, set CH-1 in DC 50Ω coupling mode, set CH-3 and CH-4 in DC 1MΩ coupling mode, set CH-2 in AC 1MΩ coupling mode, select CH-4 as trigger source, and execute the “de-gauss” of the current probe to remove possible dc bias in the current probe.

2) turn on the POWER SUPPLY (ensure that the “OUT ON” button is OFF), set the DYNAMIC MODE, with a 250Hz, 50% duty-cycle square-wave voltage between 18V and 20V (you can adjust these values based on the features of the POWER SUPPLY, ensuring that the input voltage is limited within the 18V to 20V range), and set the CURRENT LIMIT at 4.5A

3) turn on the ELECTRONIC LOAD (ensure that the “LOAD ON” button is OFF), set the DC CURRENT at 0.5A

4) turn ON the POWER SUPPLY “OUT ON” button and the “LOAD ON” button of the ELECTRONIC LOAD. In these conditions you should see the DC+AC output voltage waveform on the CH-2 trace as a flat line around 24V level with small periodical surges, the AC component of the output voltage waveform on CH-3 trace as a flat line around 0V level with small periodical surges, the input voltage waveform on CH-4 trace as a square-wave between 18V and 20V, and the inductor current waveform on the CH-1 trace as a square-wave between about 0.6A and 2.5A (if the waveforms you see are much different than as described above, turn OFF the the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY and verify previous steps)

5) read the magnitude of the output voltage surges with cursor or measurement functions of the OSCILLOSCOPE, record the values in Table 1 and repeat this step for all the load current values listed in Table 1 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button and the ELECTRONIC LOAD “LOAD ON” button while changing the load current)

6) turn OFF the the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, open the jumper J20 and short the jumper J19 to set the voltage error amplifier at high crossover with small slope compensation, and repeat the steps 4) and 5)

7) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments
Test#2: measure and calculate

For the operating conditions of Table 2:
1) measure the peak output voltage overshoot and undershoot with a dynamic voltage source connected to the input, imposing a 18V to 20V square-wave, and an adjustable DC load connected to the output
2) calculate the coefficients $\omega_{LF}$ and $\omega_{HF}$ of the PSRR formulae (6) provided in the Theory Background section
3) compare the magnitude of the output voltage line transient overshoot/undershoot with the magnitude of the coefficients $\omega_{LF}$ and $\omega_{HF}$ [NOTE: a higher $\omega_{LF}$ and a lower $\omega_{HF}$ improve the PSRR_LF and the PSRR_HF, respectively, and a better PSRR is expected to correspond to a smaller magnitude of line transient output voltage surges]

Table 2. Line transient response of LM5122 boost regulator with $f_s = 500\text{kHz}$, $R_{sl} = 100k\Omega$, $L = 10\mu\text{H}$, SOM setup, and different crossover and load current setup

<table>
<thead>
<tr>
<th>$\Delta V_{out}$ [mV]</th>
<th>$\omega_{LF}$ [rad/s]</th>
<th>$\omega_{HF}$ [rad/s]</th>
<th>(a) low crossover ($J_{18}$ op, $J_{19}$ op, $J_{20}$ sh) with low slope ($J_{14}$ sh)</th>
<th>(b) high crossover ($J_{18}$ op, $J_{19}$ sh, $J_{20}$ op) with low slope ($J_{14}$ sh)</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_{in}$: 18V $\rightarrow$ 20V(*)</td>
<td>1</td>
<td>2</td>
<td>3</td>
<td>1</td>
</tr>
<tr>
<td>$V_{in}$: 20V $\rightarrow$ 18V(*)</td>
<td>1</td>
<td>2</td>
<td>3</td>
<td>1</td>
</tr>
</tbody>
</table>

(*) the extreme values 18V and 20V can be changed according to available power supply limitations. It is recommended to not exceed 2V peak-to-peak amplitude and to keep the minimum input voltage above 15V.

Feedback compensation components:
- $J_{18}$ sh, $J_{19}$ op, $J_{20}$ op: $R_c=R_{23}=169\Omega$, $C_c=C_{28}=1nF$, $C_h=C_{33}=27pF$; [high $\omega_c$ with $L=10\mu\text{H}$, $R_{sl}=10k\Omega$]
- $J_{18}$ op, $J_{19}$ sh, $J_{20}$ op: $R_c=R_{24}=178\Omega$, $C_c=C_{29}=330pF$, $C_h=C_{34}=82pF$; [high $\omega_c$ with $L=10\mu\text{H}$, $R_{sl}=100k\Omega$]
- $J_{18}$ op, $J_{19}$ op, $J_{20}$ sh: $R_c=R_{25}=24.3k\Omega$, $C_c=C_{30}=22nF$, $C_h=C_{35}=4.7nF$; [low $\omega_c$ with $L=10\mu\text{H}$, $R_{sl}=100k\Omega$]

Switching frequency:
- $J_{14}$ open $\rightarrow f_s = 250\text{kHz}$
- $J_{14}$ shorted $\rightarrow f_s = 500\text{kHz}$

Current control slope compensation:
- $J_{14}$ open $\rightarrow R_c=100.9k\Omega$ [low slope]
- $J_{14}$ shorted $\rightarrow R_c=10k\Omega$ [high slope]

Answer:

1. Does the magnitude of output voltage transient surges increase or decrease with lower crossover setup?

   - [ ] increases  [ ] decreases  [ ] it depends on: __________________________

2. Is the magnitude of the coefficients $\omega_{LF}$ and $\omega_{HF}$ consistent with the magnitude of the output voltage surges?

   - [ ] yes  [ ] no  [ ] it depends on: __________________________

3. Identify and discuss the combination of slope compensation, cross-over setup and load current which determines the best line transient performance and best PSRR:

   __________________________
In Test#1 we are interested in investigating the impact of slope compensation on the line transient performance of the LM5122 boost regulator.

The formulae and the figures shown in the Theory Background section highlight how the boost regulator with peak current control reacts to input voltage perturbations and how the slope compensation impacts the PSRR and the corresponding time domain line transient response of the LM5122 boost regulator. Figure 2(a) shows the inherent feedforward action of the peak current control. In theory, should the input voltage change step-wise, the duty-cycle would immediately be adjusted in the subsequent switching cycle. In fact, the ramp signal $V_s$ determines the duty-cycle when it intersects the control signal $v_c$ generated by the error amplifier, as shown in Figure 2(a). The ramp signal $V_s$ includes the compensation ramp $V_{ramp}$ and the inductor current ramp signal $V_{sn}$, whose slope during the ON time of the MOSFET Q is proportional to the input voltage. The consequent duty-cycle step change would then be followed by a transient response characterized by a rate of convergence to steady-state which is influenced by the voltage feedback error amplifier setup and by the current slope compensation setup. For a given error amplifier setup, the influence of the current slope compensation is shown by formulae (1), (2) and (6) and by Figure 3(a). Formulae (1) and (2) highlight that a higher slope resistance $R_{sl}$ determines a higher gain of the PWM current mode modulator $F_m$, which involves a higher sensitivity of the duty-cycle $d$ to the perturbations of the inductor current $i_L$, control signal $v_c$ and output voltage $v_{out}$. This means that the controller will rapidly react to the output voltage to the regulated steady-state value, as shown in the time domain line transient response plot of Figure 3(b). The Formula of PSRR$_{lf}$ (6) and the Bode plot of Figure 3(a) highlight the same concept in the frequency domain: the higher gain of the PWM current mode modulator $F_m$ determined by a higher $R_{sl}$ value yields a lower PSRR$_{lf}$, which means a better capability of the PCC boost regulator to damp the effects of input voltage perturbations on the output voltage. In real world line transients, the input voltage never changes step-wise, but rather it rises or falls with a limited slew-rate, which is influenced by the output capacitance of the voltage source, by the line inductance and by the input capacitor of the boost regulator. Even more so, in this case the output voltage surges during line transient response are characterized by a smaller magnitude and a shorter duration thanks to the higher gain of the PWM current mode modulator $F_m$ determined by a higher $R_{sl}$ value. It is worth remarking that a higher slope compensation resistance $R_{sl}$ determines an improvement as in the feedforward action of the peak current mode control as in the voltage feedback loop gain. The improvement of the feedforward action is determined by the fact that when $R_{sl}$ is higher, the magnitude of the current compensation ramp, represented in yellow in Figure 2(a), is smaller. As a consequence, the duty-cycle is more directly determined by the inductor current ramp signal $V_{sn}$ whose slope is proportional to the input voltage. The slope of the compensation ramp has to be higher than a minimum threshold value to guarantee the stability of the current loop [6]. This limits the maximum value of the slope compensation resistance $R_{sl}$.

In Test#2 we are interested in investigating the impact of the voltage loop gain crossover on the line transient performance of the LM5122 boost regulator.

The formulae and the figures shown in the Theory Background section highlight how the boost regulator with peak current control reacts to input voltage perturbations and how the voltage feedback error amplifier impacts the PSRR and the corresponding time domain line transient response of the LM5122 boost regulator. For a given current control slope compensation setup, a higher crossover $\omega_c$ involves a higher frequency $\omega_c = \omega_c/(|G_v|/\alpha_v)$ in the Error Amplifier gain $G_v(s)$ given by (5). Formulae (8) highlights that an error amplifier designed to achieve a higher crossover frequency $\omega_c$ determines a lower PSRR$_{lf}$, as it is inversely proportional to $\omega_c$, as shown by formulae (8) and by Figure 3(a). As discussed above, a lower PSRR$_{lf}$ means a better capability of the PCC boost regulator in damping the effects of input voltage perturbations on the output voltage. Unlike a higher slope compensation resistance $R_{sl}$, a higher crossover frequency $\omega_c$ does not improve the feedforward capability but only the voltage feedback loop gain. Ultimately, the major improvements of the input disturbance rejection capability and of the line transient response of the a boost regulator are mostly determined by the inherent feedforward action of the peak current control, which can be maximized with a low slope compensation ramp. The voltage loop gain crossover frequency, instead, is more influential on the load transient response, which is the subject of Experiment 6.
The plots of Figures 7 to 10 show the results of experimental measurements of the LM5122 boost regulator line transient response.

The plots of Figures 7 and 8 highlight the impact of the slope compensation setup on the line transient response of the LM5122 boost regulator, for a given load current and with a setup of the voltage feedback error amplifier such as to ensure high loop gain crossover in both cases. The magnitude of the output voltage surge is clearly smaller in Figure 8, corresponding to low slope compensation setup, compared to Figure 7, corresponding to high slope compensation setup. A low slope compensation setup also ensures a faster transient. Indeed, the time the controller takes to regulate the output voltage in the case of Figure 8 is shorter than the time the controller takes to regulate the output voltage in the case of Figure 7 (this is defined as settling time, which is the time elapsed from the application of the line voltage step change to the time from which the output voltage remains within a specified error band, e.g. 1% of the steady state regulated value).

[NOTE: the oscilloscope acquisitions shown in Figures 7 to 10 have been obtained with 20MHz bandwidth limit, +3bit digital filter and 10 sweeps average, to remove the switching frequency ripple]
The plots of Figures 9 and 10 highlight the impact of the voltage feedback error amplifier setup on the line transient response of the LM5122 boost regulator, for a given load current and with a low slope compensation setup. The magnitude of the output voltage surge is clearly smaller in Figure 9, corresponding to a setup of the voltage feedback error amplifier ensuring a high crossover frequency of the loop gain, compared to Figure 10, corresponding to a setup of the voltage feedback error amplifier ensuring a low crossover frequency of the loop gain. The settling time in case of Figure 10 is also much longer (it falls beyond the scope) than the settling time in the case of Figure 9.
Experiment 6

The goal of this experiment is to analyze how the operating conditions, the peak current control slope compensation and the voltage feedback compensation influence the load transient response of the boost converter. The LM5122 boost regulator is used for this experiment.
The TI-PMLK LM5122 boost regulator operates with $V_{in}=[9,20]$V, while regulating the output voltage at the nominal value $V_{out}=24$V, $I_{out}=[0,2]$A. Figure 1 shows the basic circuit schematic. The power devices highlighted in the figure are: the input capacitor ($C_{in}$), the inductor ($L$), the output capacitor ($C_{out}$), the MOSFETs ($Q_1,Q_2$), the feedback compensation ($R_{fb1},R_{fb2},C_{f1},R_{f2},C_{f2}$), the current slope compensation resistor ($R_{slope}$) and the inductor current sensing resistor ($R_s$). The load transient response of a dc-dc regulator is important in all the applications where the load is expected to change rapidly. A regulator has a better load transient response if the magnitude of the output voltage surges caused by the load current changes is smaller. The Output Impedance of a regulator $O(f)=-\frac{\Delta V_{out}(f)}{\Delta I_{out}(f)}$ is the ratio of the perturbations of the output voltage $\Delta V_{out}$ and the perturbation of the output current $\Delta I_{out}$, as function of the frequency $f$ of the output current perturbation. The $O(f)$ function depends on the current-mode control setup, on the passive power components, on line/load operating conditions and on the voltage feedback error amplifier gain. If $O(f)$ is small, the load transient response is good. The reverse Power Supply Rejection Ratio $rPSRR(f)=\frac{\Delta I_{in}(f)}{\Delta I_{out}(f)}$ provides a measure of how much the perturbations of the output current $\Delta I_{out}$ propagate backwards to the input current $\Delta I_{in}$ as functions of the frequency $f$ of the output current perturbation. The $rPSRR(f)$ is flat over the frequency range where the $O(f)$ is small, so that a better load transient response (that is, having $O(f)$ small over a wider frequency range) involves a lower load-to-line current noise rejection.

(1) Restricted range adopted for this educational board, compared to the 4.5V to 65V full range of LM5122 [4]

**Test#1.** We measure the magnitude of the output voltage surges caused by a square-wave load current, at different input voltage and with different setup of the voltage feedback compensation, providing different crossover with a given slope compensation setup.

**Test#2.** We measure the magnitude of the output voltage surges caused by a square-wave load current, at different input voltage and with different setup of the slope compensation of the current control loop. The voltage feedback compensation is setup to keep the crossover frequency high with the different slope compensation setup.
Figure 2 shows the schematic of LM5122 boost regulator with the main elements of the peak-current control circuitry.

In some applications the load current can vary rapidly, nearly stepwise. The regulator has to attenuate the effects of such load changes, by limiting the magnitude of the output voltage overshoot/undershoot surges and the slew-rate of the input current, to comply with the required power supply specifications. The current loop and voltage loop play different roles in the achievement of these goals. The Theory Background section of Experiment 5 provides the fundamentals to determine the closed loop frequency response of the LM5122 boost regulator to input line perturbations. The same procedure can be applied to determine the Output Impedance $Z_{out}(s) = \frac{V_{out}}{I_{out}}$ at Low Frequency (LF) and High Frequency (HF) given by (1) (see Experiment 5 for symbols):

$$Z_{out}(s) = \frac{sM}{\omega_c s^2 + 1}$$

where $M = \frac{V_{out}}{V_{in}}$. The factor $\omega_c$ depends on the loop gain crossover frequency (see Experiment 5), which is setup by the voltage feedback Error Amplifier (EA). The formula (1) shows that the EA influences $Z_{out}(s)$, the ESR of the output capacitor and the current control slope compensation influence the $Z_{out}(s)$ whereas the line and load conditions influence the $Z_{out}$ globally. The Reverse Power Supply Rejection Ration $r_{PSRR}(s) = \frac{V_{in}}{I_{out}}$ can be obtained in the same way. The formulae at Low Frequency (LF) and High Frequency (HF) are given by (2):

$$r_{PSRR}_{LF} = M, \quad r_{PSRR}_{HF} = \frac{1}{LM} \left( V_{out} + \frac{f_c f_m M}{1 + f_c f_m} \right)$$

The formulae (2) show that the feedback Error Amplifier setup does not influence $r_{PSRR}_{LF}$, and $r_{PSRR}_{HF}$. Indeed the $r_{PSRR}_{HF}$ is imposed by the voltage conversion ratio. The Error Amplifier setup determines the frequency below which the $r_{PSRR}$ equals $r_{PSRR}_{LF}$ (this is highlighted in Figure 4). The formulae (2) show that the ESR of the output capacitor and the current control slope compensation influence $r_{PSRR}_{HF}$ whereas line/load operating conditions influence the $r_{PSRR}$ globally. Figure 3 shows effects of crossover $\omega_c$ setup on $Z_{out}$ and load step response: a higher $\omega_c$ improves the low frequency load noise rejection, whereas it is does not influence high frequency noise rejection.

Figure 4 shows that a higher $\omega_c$ expands the $r_{PSRR}$ bandwidth whereas it does not influence low frequency noise rejection.

The fundamentals of load transient response of peak-current controlled boost converter in CCM and its correlation with the output impedance and the reverse PSRR are discussed below (see [1],[2],[3] and [6] for more details on boost topology operation, dynamic modeling and and current-mode control analysis and design; see [4] for more details on LM5122 operation and features).

Good to know:

The formulae (1) and (2) provided in this section are determined by using the model of the boost converter without the input capacitor. This allows to investigate the inherent load noise rejection capability of a peak-current mode controlled boost regulator. The formula shows that the crossover frequency determines the bandwidth of the line and load noises against which the voltage feedback Error Amplifier is able to immunize the output voltage $V_{out}$. The wider the bandwidth of load noise rejection required by $V_{out}$, the faster the reaction of the inductor has to be, and worse the $r_{PSRR}$ gets. The input capacitor $C_m$ helps in reducing the $r_{PSRR}_{LF}$ bandwidth.
The instruments needed for this experiment are: a DC POWER SUPPLY, an ELECTRONIC LOAD with DYNAMIC MODE features and an OSCILLOSCOPE. Figure 5 shows the instruments connections. Follow the instructions provided in next page to set-up the connections.

**WARNING!**
Keep the wires 3) and 4) as short as possible to limit the parasitic inductance.
Experiment set-up: instructions

With all the instruments turned off, make the following connections:

1) connect the POSITIVE (RED) OUTPUT of the DC POWER SUPPLY to the INPUT (VIN) of the J11 screw terminal of the LM5122 boost regulator

2) connect the NEGATIVE (BLACK) OUTPUT of the DC POWER SUPPLY to the GROUND (GND) of the J11 screw terminal of the LM5122 boost regulator

3) connect the OUTPUT (VOUT) of the J12 screw terminal of the LM5122 boost regulator to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD

4) connect the GROUND (GND) of the J12 screw terminal of the LM5122 boost regulator to the NEGATIVE (BLACK) INPUT of the ELECTRONIC LOAD

5) connect a current probe to channel 1 of the OSCILLOSCOPE and hang it on the cable connecting the OUTPUT (VOUT) of the J12 screw terminal of the LM5122 boost regulator to the POSITIVE (RED) INPUT of the ELECTRONIC LOAD, ensuring that the arrow printed on the probe clamps corresponds to the current that enters the ELECTRONIC LOAD

6) connect a voltage probe to channel 2 of the OSCILLOSCOPE, hang its positive tip to TEST PIN TP12 which is the output voltage of the LM5122 boost regulator. This probe will be used to measure the DC+AC components of the output voltage
   [WARNING: DO NOT INVERT the positive and ground connections of the voltage probe]

7) connect a voltage probe to channel 3 of the OSCILLOSCOPE, hang its positive tip to TEST PIN TP12 which is the output voltage of the LM5122 boost regulator. This probe will be used to measure the AC component of the output voltage
   [WARNING: DO NOT INVERT the positive and ground connections of the voltage probe]

8) connect a current probe to channel 4 of the OSCILLOSCOPE and hang it on the sensing resistor R11 of the LM5122 boost regulator, ensuring that the arrow printed on the probe clamps corresponds to the current that enters the inductor (the arrow must point upside when looking the LM5122 boost board frontally, as shown in Figure 5)
Initial jumpers set-up (see Figure 6):

- J13 open → no external synchronization signal connected
- J14 open → $R_{sl}=100\,\text{k}\Omega$ (low slope current mode compensation)
- J15 shorted → switching frequency $f_s = 500\,\text{kHz}$
- J16 shorted left → SOM setup
- J18 open, J19 shorted, J20 open → error amplifier gain setup with parts $R_{23}, C_{28}, C_{33}$ connected (high cross-over frequency with $L = L_3 = 10\,\mu\text{H}$, and low slope compensation ramp)
- J23 - J24 shorted → $L_3 (10\,\mu\text{H})$ inductor connected

Test Procedure:

1) turn on the OSCILLOSCOPE, set CH-1 and CH-4 in DC $50\,\Omega$ coupling mode, select CH-4 as trigger source, execute the “de-gauss” of the current probe to remove possible DC bias in the current probe, set CH-2 in DC $1\,\text{M}\Omega$ coupling mode, CH-3 in AC $1\,\text{M}\Omega$ coupling mode
2) turn on the POWER SUPPLY (ensure that the “OUT ON” button is OFF), set the DC VOLTAGE at 10V, and set the CURRENT LIMIT at 1A
3) turn on the ELECTRONIC LOAD (ensure that the “LOAD ON” button is OFF), set the DYNAMIC CURRENT MODE and fix the low current level at 100mA for 5ms, the high current level at 300mA for 5ms, the current rise and fall slew-rates at the highest level allowed by the instrument
4) turn ON the POWER SUPPLY “OUT ON” button. In these conditions you should see the load current on the CH-1 trace of the OSCILLOSCOPE as a flat waveform at zero level, the DC+AC components of the output voltage on the CH-2 trace as a flat waveform at 24V average value, the AC component of output voltage on CH-3 trace as a flat waveform at zero level, and the inductor current on CH-4 trace as a flat line at 0A level (if the waveforms do not look as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
5) turn ON the ELECTRONIC “LOAD ON” button. In these conditions you should see the load current on the CH-1 trace of the OSCILLOSCOPE as a square-wave between 100mA and 300mA, the DC+AC components of the output voltage on the CH-2 trace as a waveform with 24V average value with small positive and negative surges at the instants of the load current steps, the AC component of output voltage on CH-3 trace as a flat waveform at zero level, and the inductor current on CH-4 trace as a square-wave between 250mA and 750mA (if the waveforms do not look as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
6) record in Table 1 the magnitude of the output voltage surges after each load transient for the input voltage values listed in Table 1 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button while adjusting the input voltage)
7) turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then open the jumper J14 and short the jumper J19 to change the voltage feedback error amplifier setup, repeat the steps 4) to 6), and report the results in Table 1
8) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments
Test#1: measure and calculate

For the operating conditions of Table 1:
1) measure the magnitudes of output voltage surges $\Delta V_{\text{out,over}}$ and $\Delta V_{\text{out,under}}$
2) calculate the factor $\omega_f=\omega_c/(A_M)$ of the output impedance $Z_{\text{out,LF}}$ given by formula (1) of the Theory Background section [NOTE: refer to the Theory Background section of Experiment 5 to calculate the frequency factor $\omega_c$ as a function of the parameters of the feedback compensation components]
3) compare the magnitude of the load transient output voltage surges with the value of the frequency factor $\omega_f$ [NOTE: a higher $\omega_f$ makes the $Z_{\text{out,LF}}$ smaller, and this is expected to correspond to a smaller magnitude of load transient output voltage surges, that is a better load transient response]

Table 1. Output voltage load transient surges of the LM5122 boost regulator, with $f_s=500\text{kHz}$, $L=10\mu\text{H}$, low slope compensation, and different input voltage and feedback error amplifier setup

<table>
<thead>
<tr>
<th>Case</th>
<th>Input voltage</th>
<th>$I_{\text{OUT}}$: $300\text{mA} \rightarrow 100\text{mA}$</th>
<th>$I_{\text{OUT}}$: $100\text{mA} \rightarrow 300\text{mA}$</th>
</tr>
</thead>
<tbody>
<tr>
<td>(a)</td>
<td>$V_{\text{in}}=10\text{V}$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
</tr>
<tr>
<td>J18 op</td>
<td>$V_{\text{in}}=15\text{V}$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
</tr>
<tr>
<td>J19 sh</td>
<td>$V_{\text{in}}=20\text{V}$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
</tr>
<tr>
<td>(b)</td>
<td>$V_{\text{in}}=10\text{V}$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
</tr>
<tr>
<td>J18 op</td>
<td>$V_{\text{in}}=15\text{V}$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
</tr>
<tr>
<td>J19 op</td>
<td>$V_{\text{in}}=20\text{V}$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
<td>$\Delta V_{\text{OUT,over}}[\text{mV}] = \omega_f[\text{rad/s}] = \Delta V_{\text{OUT,under}}[\text{mV}] = \omega_f[\text{rad/s}]$</td>
</tr>
</tbody>
</table>

Feedback compensation components:
- J18 sh, J19 op, J20 op: $R_c=R_{23}=169\Omega$, $C_c=C_{28}=1\text{nF}$, $C_h=C_{33}=27\text{pF}$; [high $\omega_c$ with $L=10\mu\text{H}$, $R_s=10k\Omega$]
- J18 op, J19 sh, J20 op: $R_c=R_{24}=178\Omega$, $C_c=C_{29}=330\text{pF}$, $C_h=C_{34}=82\text{pF}$; [high $\omega_c$ with $L=10\mu\text{H}$, $R_s=100k\Omega$]
- J18 op, J19 op, J20 sh: $R_c=R_{25}=24.3k\Omega$, $C_c=C_{30}=22\text{nF}$, $C_h=C_{35}=4.7\text{nF}$; [low $\omega_c$ with $L=10\mu\text{H}$, $R_s=100k\Omega$]

Switching frequency:
- J14 open $\rightarrow f_s = 250\text{kHz}$
- J14 shorted $\rightarrow f_s = 500\text{kHz}$

Current control slope compensation:
- J14 open $\rightarrow R_s=100.9k\Omega$ [low slope]
- J14 shorted $\rightarrow R_s=10k\Omega$ [high slope]

Answer:

1. Are the surges magnitude bigger for case (a) or for case (b) ?  
   - (a)  
   - (b)  
   - same  
   - it depends on: ___________________________

2. Does the surges magnitude increase with the input voltage ?  
   - yes  
   - no  
   - it is insensitive  
   - other: ___________________________

3. Is the magnitude of transient surges consistent with the value of $\omega_f$ ?  
   - yes  
   - no  
   - it depends on: ___________________________
Test#2: preparation and procedure

Initial jumpers set-up (see Figure 7):
- J13 open → no external synchronization signal connected
- J14 open → Rs=100kΩ (low slope current mode compensation)
- J15 shorted → switching frequency fs = 500kHz
- J16 shorted left → SOM setup
- J18 open, J19 shorted, J20 open → error amplifier gain setup with parts R23, C28, C33 connected (high cross-over frequency with L = L3 = 10µH, and low slope compensation ramp)
- J23 - J24 shorted → L3 (10µH) inductor connected

Test Procedure:
1) turn on the OSCILLOSCOPE, set CH-1 and CH-4 in DC 50Ω coupling mode, select CH-4 as trigger source, execute the “de-gauss” of the current probe to remove possible dc bias in the current probe, set CH-2 in DC 1MΩ coupling mode, CH-3 in AC 1MΩ coupling mode
2) turn on the POWER SUPPLY (ensure that the “OUT ON” button is OFF), set the DC VOLTAGE at 10V, and set the CURRENT LIMIT at 1A
3) turn on the ELECTRONIC LOAD (ensure that the “LOAD ON” button is OFF), set the DYNAMIC CURRENT MODE and fix the low current level at 100mA for 5ms, the high current level at 300mA for 5ms, the current rise and fall slew-rates at the highest level allowed by the instrument
4) turn ON the POWER SUPPLY “OUT ON” button. In these conditions you should see the load current on the CH-1 trace of the OSCILLOSCOPE as a flat waveform at zero level, the DC+AC components of the output voltage on the CH-2 trace as a flat waveform at 24V average value, the AC component of output voltage on CH-3 trace as a flat waveform at zero level, and the inductor current on CH-4 trace as a flat line at 0A level (if the waveforms do not look as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
5) turn ON the ELECTRONIC “LOAD ON” button. In these conditions you should see the load current on the CH-1 trace of the OSCILLOSCOPE as square-wave between 100mA and 300mA, the DC+AC components of the output voltage on the CH-2 trace as a waveform with 24V average value with small positive and negative surges at the instants of the load current steps, the AC component of output voltage on CH-3 trace as a flat waveform at zero level with small positive and negative surges at the instants of the load current steps, and the inductor current on CH-4 trace as a square-wave between 250mA and 750mA (if the waveforms do not look as described above, turn OFF the “OUT ON” button of the DC POWER SUPPLY and verify the previous steps)
6) record in Table 1 the magnitude of the output voltage surges after each load transient for the input voltage values listed in Table 1 (you do not need to turn OFF the POWER SUPPLY “OUT ON” button while adjusting the input voltage)
7) turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then short the jumper J14, to change the slope compensation setup, open the jumper J18 and short the jumper J19, to setup the voltage feedback error amplifier, repeat the steps 4) to 6), and report the results in Table 1
8) at the end of the measurements, turn OFF the “LOAD ON” button of the ELECTRONIC LOAD and the “OUT ON” button of the DC POWER SUPPLY, then switch off all the instruments
Test#2: measure and calculate

For the operating conditions of Table 2:
1) measure the magnitudes of output voltage surges $\Delta V_{\text{out,over}}$ and $\Delta V_{\text{out,under}}$
2) calculate the factor $\omega_L=\frac{\omega_f}{[\text{A/M]}}$ of the output impedance $Z_{\text{out,LF}}$ given by formula (1) of the Theory Background section [NOTE: refer to the Theory Background section of Experiment 5 to calculate the frequency factor $\omega_f$ as a function of the parameters of the feedback compensation components]
3) compare the magnitude of the load transient output voltage surges with the value of the frequency factor $\omega_L$ [NOTE: a higher $\omega_L$ makes the $Z_{\text{out,LF}}$ smaller, and this is expected to correspond to a smaller magnitude of load transient output voltage surges, that is a better load transient response]

| Table 1. Output voltage surges of the LM5122 boost regulator during load transients, with $f_s=500kHz$, $L=10\mu H$ and different input voltage and slope compensation setup

<table>
<thead>
<tr>
<th>Input voltage</th>
<th>$I_{\text{OUT}}: 300mA \rightarrow 100mA$</th>
<th>$I_{\text{OUT}}: 100mA \rightarrow 300mA$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$	ext{J}_{14}\text{op}$</td>
<td>$V_{\text{in}}=10V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
<tr>
<td>$\text{J}_{15}\text{op}$</td>
<td>$V_{\text{in}}=15V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
<tr>
<td>$\text{J}_{16}\text{op}$</td>
<td>$V_{\text{in}}=20V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
<tr>
<td>$\text{J}_{17}\text{sh}$</td>
<td>$V_{\text{in}}=10V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
<tr>
<td>$\text{J}_{18}\text{sh}$</td>
<td>$V_{\text{in}}=15V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
<tr>
<td>$\text{J}_{19}\text{op}$</td>
<td>$V_{\text{in}}=20V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
<tr>
<td>$\text{J}_{20}\text{op}$</td>
<td>$V_{\text{in}}=10V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
<tr>
<td>$\text{J}_{21}\text{op}$</td>
<td>$V_{\text{in}}=15V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
<tr>
<td>$\text{J}_{22}\text{op}$</td>
<td>$V_{\text{in}}=20V$</td>
<td>$\Delta V_{\text{OUT,over}} \text{[mV]}$</td>
</tr>
</tbody>
</table>

(1) the error amplifier setup is changed too to ensure the crossover frequency does not change significantly.

Feedback compensation components:
- J14, J16, J20 op: $R_{c}=R_{23}=169\Omega$, $C_{c}=C_{28}=1nF$, $C_{h}=C_{33}=27pF$; [high $\omega_f$ with $L=10\mu H$, $R_s=10k\Omega$]
- J15, J16, J20 sh: $R_{c}=R_{23}=178\Omega$, $C_{c}=C_{29}=330pF$, $C_{h}=C_{34}=82pF$; [high $\omega_f$ with $L=10\mu H$, $R_s=100k\Omega$]
- J15, J16, J20 sh: $R_{c}=R_{23}=24.3k\Omega$, $C_{c}=C_{30}=22nF$, $C_{h}=C_{35}=4.7nF$; [low $\omega_f$ with $L=10\mu H$, $R_s=100k\Omega$]

Switching frequency:
- J14 open $\rightarrow f_s=250kHz$
- J14 shorted $\rightarrow f_s=500kHz$

Current control slope compensation:
- J14 open $\rightarrow R_s=100.9k\Omega$ [low slope]
- J14 shorted $\rightarrow R_s=10k\Omega$ [high slope]

Answer:
1. Are the surges magnitude bigger for case (a) or for case (b) ?
   - (a) ☐ (b) ☐ same ☐ it depends on: ☐
2. Does the surges magnitude increase with the input voltage ?
   - yes ☐ no ☐ it is insensitive ☐ other: ☐
3. Is the magnitude of transient surges consistent with the value of $\omega_L$ ?
   - yes ☐ no ☐ it depends on: ☐
In Test#1 we are interested in investigating the impact of the voltage feedback loop gain crossover determined by the feedback error amplifier setup on the load transient performance of the LM5122 boost regulator.

The formulae and the figures shown in the Theory Background section highlight how the boost regulator with peak current control reacts to load current perturbations and how the voltage feedback error amplifier setup impacts the output impedance $Z_{out}$ gain and the corresponding time domain load transient response of the LM5122 boost regulator. Formulae (1) and Figure 3(a) show that the error amplifier setup mainly impacts the low frequency output impedance $Z_{out,LF}$, which is improved by a higher crossover frequency $\omega_c$. Improved load perturbation rejection capability is shown in Figure 3(b) due to higher crossover frequency setup. The cross-over frequency of the boost regulator voltage loop gain is determined by the poles and zeros of the feedback compensation error amplifier. If the poles and zeros of the error amplifier are placed so as to set a higher crossover frequency, its gain will have a higher magnitude over a wider frequency range. This involves that the effects of load perturbations are more strongly magnified by the error amplifier, by changing more intensely its output voltage $v_c$, which is the reference or the peak inductor current. Thus, a higher crossover determines a faster adaptation of the inductor current to the load demand and ensures a faster response of the boost regulator to load transients. In particular, the magnitude of the output voltage transient surges is smaller as the boost regulator reacts faster to the load perturbation and this shortens the duration of the time interval wherein the output capacitor has to sustain the unbalance between the instant power transferred from the input to the load through the inductor and the load power demand. Although a higher crossover frequency has beneficial effects on load transient performance, its value cannot be too high for two reasons. A first absolute limit that cannot be exceeded is determined by the switching frequency. In fact, a crossover frequency higher than the switching frequency is not allowed, as in that case the error amplifier would try to damp the switching ripple of the output voltage, which is not a disturbance determined by load variations but rather the beat of the converter. The ripple limiting, in fact, is achieved by means of an adequate output capacitor. The second limit for the crossover frequency is determined by the couple of poles introduced in the voltage loop gain at half the switching as a consequence of the sampling mechanism characterizing the peak current mode control [6]. These poles introduce a phase lag which depends on the slope of the compensation ramp and that increases while approaching half the switching frequency, where it becomes $-90^\circ$. In theory, a Type III error amplifier could provide the due phase boost to achieve the desired phase margin. However, the global asymptotic stability requirement imposes that the phase of the loop gain is greater than $-180^\circ$ from DC to the crossover frequency. Thus, a high crossover frequency and global asymptotic stability could not be jointly achievable, and the design of an error amplifier intended to achieve a crossover frequency too close to one half of the switching frequency can be unfeasible with a Type II and even with a Type III error amplifier. Formulae (1) also highlight that high frequency output impedance $Z_{out,HF}$ is dominated by the ESR of the output capacitor and is not influenced by the error amplifier. In fact, should the load perturbation be characterized by a frequency higher than the crossover, the feedback controller would not be able to follow and compensate it. Therefore, a low ESR is required to keep low the high frequency output impedance and limit the magnitude of the output voltage surges determined by high slew-rate load transients.

In Test#2 we are interested in investigating the impact of the peak current control modulator gain determined by the slope compensation setup on the load transient performance of the LM5122 boost regulator.

The formulae (1) shown in the Theory Background section highlight that the slope compensation setup does not directly impact the low frequency output impedance $Z_{out,LF}$, whereas it has a minor influence on the high frequency output impedance $Z_{out,HF}$. Ultimately, the major improvements of the load disturbance rejection capability and of the load transient response of the boost regulator are mostly determined by the voltage feedback error amplifier setup, and are maximized by a high voltage loop gain crossover frequency. The slope compensation setup, instead, is more influential on the line transient response, which is the subject of Experiment 5.
The plots of Figures 8 to 11 show some examples of experimental measurements of LM5122 boost regulator load transient response.

The plots of Figures 8 and 9 show the impact of the loop gain crossover frequency on the load transient response, for given input voltage and low slope compensation setup. The magnitude of the output voltage surge is clearly smaller in Figure 8, corresponding to high crossover frequency setup, compared to Figure 9, corresponding to low crossover frequency setup. A higher crossover frequency also ensures a faster transient. Indeed, the time the controller takes to regulate the output voltage in the case of Figure 8 is much shorter than the time the controller takes to regulate the output voltage in the case of Figure 9 (this is defined as settling time, which is the time elapsed from the application of the load current step to the time from which the output voltage remains within a specified error band, e.g. 1% of the steady state regulated value). The inductor transient waveform allows to highlight the impact of the crossover frequency setup on the reverse PSRR, discussed in the Theory Background section. In fact, the plot of Figure 8 shows that the waveform of the inductor current (green trace) looks like a square wave similar to the load current square wave. This means that under conditions of high crossover frequency, the high frequency noise easily propagates to the input side, as the inductor is on the input side in the boost converter. Then, a higher input capacitance is required to limit the line current load transient slew-rate. The plot of Figure 9, instead, shows that the inductor current waveform has a smoother transition from low to high level and viceversa, which means that with low crossover frequency the square wave load current is better filtered towards the input line. In these conditions, a smaller input capacitor is required to limit the line current load transient slew-rate.

[NOTE: the oscilloscope acquisitions shown in Figures 8 to 11 have been obtained with 20MHz bandwidth limit, +3bit digital filter and 10 sweeps average, to remove the switching frequency ripple]
The plots of Figures 10 and 11 show the impact of the compensation slope on the boost regulator load transient response, for given input voltage and crossover frequency setup. The magnitude of the output voltage surge is clearly smaller in Figure 11, corresponding to low slope compensation setup, compared to Figure 10, corresponding to high slope compensation setup. The settling time in the case of Figure 11 is slightly shorter than the settling time in the case of Figure 10. The high crossover frequency ensures a fast load transient response in both cases.
Appendix A

References

# Appendix B

## Manufacturers websites

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<th>Manufacturer</th>
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<td>AVX</td>
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- **XAL7030-332MEB**  
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3. **Regulatory Notices:**

3.1 United States

3.1.1 **Notice applicable to EVMs not FCC-Approved:**
This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 **For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:**

**CAUTION**
This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user’s authority to operate the equipment.

**FCC Interference Statement for Class A EVM devices**

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.
FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:
This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:
Le présent appareil est conforme aux CNR d’Industrie Canada applicables aux appareils radio exempts de licence. L’exploitation est autorisée aux deux conditions suivantes: (1) l’appareil ne doit pas produire de brouillage, et (2) l’utilisateur de l’appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d’en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:
Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables
Conformément à la réglementation d’Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d’un type et d’un gain maximal (ou inférieur) approuvé pour l’émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l’intention des autres utilisateurs, il faut choisir le type d’antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l’intensité nécessaire à l’établissement d’une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d’antenne énumérés dans le manuel d’usage et ayant un gain admissible maximal et l’impédance requise pour chaque type d’antenne. Les types d’antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l’exploitation de l’émetteur.

3.3 Japan

3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page

3.3.2 Notice for Users of EVMs Considered “Radio Frequency Products” in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan. If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:
1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.
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3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page
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4.1 EVMs ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
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